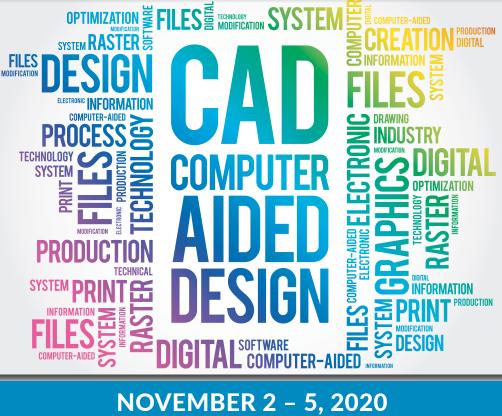
IEEE/ACM 2020 INTERNATIONAL CONFERENCE ON COMPUTER-AIDED DESIGN

ICCAD 2020 VIRTUAL EVENT



ICCAD.COM

WELCOME TO THE 39TH ICCAD



FROM YUAN XIE ICCAD GENERAL CHAIR

Welcome to the 39th edition of the International Conference on Computer-Aided Design! This year, due to the global COVID-19 pandemic, many conferences are forced to make the event work in the online world. Consequently, the ICCAD 2020 Executive Committee decided to move forward with a Virtual Conference due to the continued uncertainty surrounding the COVID-19 situation. Nevertheless, we are very excited to test out this new online edition for the first time in ICCAD's 39-year history.

Even though the virtual events lack the kind of interpersonal communications attendees get from in-person events, a much lower registration fee with no travel overheads may boost the number of participants. A carefully tuned schedule with a virtual platform can make it a true "global" event for anyone around the world to attend ICCAD. We hope you will enjoy this unique virtual experience with the first-ever online ICCAD.

Jointly sponsored by IEEE and ACM, ICCAD is the premier forum to explore emerging technology challenges in electronic design automation, present leading-edge R&D solutions, and identify future roadmaps for design automation research areas. The members of the executive committee, the technical program committee, and numerous volunteers have spent the past several months preparing an exciting program for you!

This was another strong year for ICCAD in terms of the number of regular paper submissions. We received more than 470 regular paper submissions. They were divided into 17 tracks and reviewed by 144 outstanding technical program committee members from both industry and academia worldwide. For the first time, the TPC meeting was held online without compromising the quality of the doubleblind review process. Finally, the program committee has selected 127 papers spread over 35 sessions on diverse topics. We also had a record number of special session proposals submitted to ICCAD this year. Altogether, we have 11 special sessions and two embedded tutorials on topics that complement the regular sessions.

We are delighted to host several distinguished keynote speakers: the Monday morning keynote on Al for enterprises will be given by IBM Fellow Dr. Ruchir Puri. On Tuesday, Professor Birgit Vogel-Heuser from the Technical University of Munich will present the IEEE CEDA Luncheon Distinguished Lecture on Cyber Physical Systems. Finally, Professor Yao-Wen Chang from National Taiwan University will present the Wednesday keynote on EDA for More-Moore and More-than-Moore Designs. We hope you will find these keynotes exciting and informative.

On Thursday, we have five interesting workshops planned, on a variety of both new and established topics. Some of these workshops are long-time staples of ICCAD, while others test the waters for the first time. Additionally, a workshop addressing System-level interconnect problems is co-located with ICCAD. All these workshops have exciting programs themselves, so we hope that many of you will take advantage of them.

Once again, ICCAD promises to be an ultimate destination for those working on cutting edge EDA research. We hope that you will be able to join us in making this first-ever virtual event a great and memorable one. Finally, we are grateful to our ICCAD 2020 sponsors and numerous supporters for making this year's conference another successful event.

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GENERAL INFORMATION

ICCAD 2020 Mobile Event App

Review the program, save sessions to your personalized conference schedule, read speakers abstracts, and connect with other attendees using the ICCAD 2020 mobile app provided by Whova, available for download today. Download Whova and search for **ICCAD 2020**.



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Please download the ICCAD 2020 Proceedings zip folder. Once you have it on your computer, you will need to extract the files from the zip folder. Then you will be able to see the content

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this by having a committed staff of trade show production organizers with the training, technology tools, processes and experience to offer the best service in the industry. Visit <u>mpassociates.com</u> for more information.

BEST PAPER CANDIDATES

IEEE/ACM William J. McCalla ICCAD Best Paper Award Candidates

MONDAY, NOVEMBER 2

*1B.1 Electromigration Checking Using a Stochastic Effective Current Model

Adam Issa - Univ. of Toronto Valeriy Sukharev - Mentor, A Siemens Business Farid N. Najm - Univ. of Toronto

*2C.1 Energy-Efficient Control Adaptation with Safety Guarantees for Learning-Enabled Cyber-Physical Systems

Yixuan Wang - Northwestern Univ. Chao Huang - Northwestern Univ. Qi Zhu - Northwestern Univ.

TUESDAY, NOVEMBER 3

*8C.1 HyperFuzzing for SoC Security Validation

Sujit Kumar Muduli - Indian Institute of Technology Kanpur Gourav Takhar - Indian Institute of Technology Kanpur Pramod Subramanyan - Indian Institute of Technology Kanpur

WEDNESDAY, NOVEMBER 4

*9C.1 Optimally Approximated and Unbiased Floating-Point Multiplier with Runtime Configurability

Chuangtao Chen - Zhejiang Univ. Sen Yang - Zhejiang Univ. Weikang Qian - Shanghai Jiao Tong Univ. Mohsen Imani - Univ. of California, Irvine Xunzhao Yin - Zhejiang Univ. Cheng Zhuo - Zhejiang Univ.

*10C.3 DISQ: A Novel Quantum Output State Classification Method on IBM Quantum Computers using OpenPulse

Tirthak Patel - Northeastern Univ. Devesh Tiwari - Northeastern Univ.

*12B.1 GridNet: Fast Data-Driven EM-Induced IR Drop Prediction and Localized Fixing for On-Chip Power Grid Networks

Han Zhou - Univ. of California, Riverside Wentian Jin - Univ. of California, Riverside Sheldon Tan - Univ. of California, Riverside

BEST PAPER AWARD COMMITTEES

IEEE/ACM William J. McCalla ICCAD Best Paper Award Selection Committee

Paolo lenne (Chair) - École Polytechnique Fédérale de Lausanne Chuck Alpert - Cadence Design Systems Ingrid Verbauwhede - KU Leuven Niraj Jha - Princeton Univ. Petru Eles - Linköping Univ. Puneet Gupta - Univ. of California, Los Angeles

Ten-Year Retrospective Most Influential Paper Award Selection Committee

Martin Wong (Chair) - Univ. of Illinois at Urbana-Champaign and Chinese Univ. of Hong Kong Deming Chen - Univ. of Illinois at Urbana-Champaign Evangeline Young - Chinese Univ. of Hong Kong Zhuo Feng - Stevens Institute of Technology

EMBEDDED TUTORIAL/SPECIAL SESSION COMMITTEE

Evangeline Young (Chair) - The Chinese Univ. of Hong Kong Laleh Behjat - Univ. of Calgary Tony Givargis - Univ. of California, Irvine Iris Hui-Ru Jiang - National Taiwan Univ. Hai (Helen) Li - Duke Univ. Sachin Sapatnekar - Univ. of Minnesota Sheldon Tan - Univ. of California, Riverside Yu Wang - Tsinghua Univ.

MONDAY SCHEDULE

| 6:30 - 7:00am Opening Session & Awards |
|---|
| 7:00 - 8:00am KEYNOTE: Engineering the Future of AI for the Enterprises Ruchir Puri - IBM Research. |
| 8:00 - 8:30am 1A: Routing Strategies for 2D/2.5/3D ICs 1B: Electromigration and Circuit Yield: Efficient Verification Techniques 1C: Securing Embedded and IoT Platforms |
| Special Session 1D: How Machine Leaning can Reshape Technology, Manufacturability, Performance and Power |
| 8:30 - 9:00am 2A: Machining Learning Techniques for Routing and Hotspot Detection 2B: Exploring Optimal Mask Patterns 2C: Safety and Energy Optimizations for Cyber-Physical Systems Special Session 2D: AloT: The Powerful Convergence of Al and the IoT - An Industrial Perspective |
| 9:00 - 9:30am 3A: Brain-inspired, Bio-engineering, and Emerging Computing 3B: Novel Techniques for Improving Reliability and Manufacturability 3C: Secure Architectures and Systems Design Special Session 3D: Hardware/Software Co-Design for Machine Learning in Medicine |
| 9:30 - 10:00am Thank you to our Sponsor: Delivering Improved Design Performance by Thank you to our Sponsor: Applying Machine Learning to EDA Cadence° 9:30 - 11:30am ACM Student Research Competition at ICCAD 2020 |

Opening Session and Awards Time: 6:30 -7:00am

Start off the conference with opening remarks from the ICCAD Executive Committee members and hear the highlights of the conference. The IEEE/ACM William J. McCalla ICCAD Best Paper award will be announced along with other award presentations from IEEE CEDA and ACM.

IEEE/ACM WILLIAM J. MCCALLA ICCAD BEST PAPER AWARD

This award is given in memory of William J. McCalla for his contributions to ICCAD and his CAD technical work throughout his career.

Front-End Award:

8C.1: HyperFuzzing for SoC Security Validation

Sujit Kumar Muduli, Gourav Takhar and Pramod Subramanayan - Indian Institute of Technology Kanpur

Back-End Award:

1B.1: Electromigration Checking Using a Stochastic Effective Current Model

Adam Issa - Univ. of Toronto Valeriy Sukharev - Mentor, A Siemens Business Farid N. Najm - Univ. of Toronto

TEN YEAR RETROSPECTIVE MOST INFLUENTIAL PAPER AWARD

This award is being given to the paper judged to be the most influential on research and industrial practice in computer-aided design over the ten years since its original appearance at ICCAD.

2010 Paper Titled: 3D-ICE: Fast Compact Transient Thermal Modeling for 3D Ics with Inter-Tier Liquid Cooling

A. Sridhar, A. Vincenzi, M. Ruggiero, T. Brunschwiler and D. Atienza, ICCAD 2010 pp. 463-470, doi:10.1109/ICCAD.2010.5653749.

IEEE FELLOWS

Partha Pratim Pande - Washington State Univ. For contributions to network-on-chip architectures for manycore computing.

Maciej Ciesielski - Univ. of Massachusetts For contributions to logic synthesis and formal verification of arithmetic circuits.

IEEE CEDA OUTSTANDING SERVICE RECOGNITION

David Pan - The Univ. of Texas at Austin For outstanding service to the EDA community as ICCAD General Chair in 2019.

IEEE CEDA ERNEST S. KUH EARLY CAREER AWARD

Prof. Yier Jin - Univ. of Florida For contributions to hardware security.

KEYNOTE ADDRESS

Opening Session and Awards

Time: 6:30am - 7:00am



Keynote: Engineering the Future of AI for the Enterprises *Time*: 7:00*am* - 8:00*am*

Speaker:

Ruchir Puri - IBM Research

Recent advances in AI are starting to transform every aspect of our society from healthcare, manufacturing, environment, and beyond. The future of AI

for enterprises will be engineered with success along three foundational dimensions. We will dive deeper along these dimensions - Automation of AI; Trust of AI; and Scaling of AI - and conclude with the opportunities and challenges of AI for businesses.

Biography: Dr. Ruchir Puri is the Chief Scientist of IBM Research and an IBM Fellow. He led IBM Watson as its CTO and Chief Architect from 2016-19 and has held various technical, research, and engineering leadership roles across IBM's Al and Research businesses. Dr. Puri is a Fellow of the IEEE, and has been an ACM Distinguished Speaker, an IEEE Distinguished Lecturer, and was awarded 2014 Asian American Engineer of the Year. Dr. Puri has been an adjunct professor at Columbia Univ., NY, and a visiting scientist at Stanford Univ., CA. He was honored with John Von-Neumann Chair at The Institute of Discrete Mathematics at Bonn Univ., Germany. Dr. Puri is an inventor of over 60 United States patents and has authored over 100 scientific publications on software-hardware automation methods, microprocessor design, and optimization algorithms. He is the chair of 2020 AAAI-IAAI conference that focused on industrial applications of Al. Ruchir's technical opinions on the adoption of Al by society and businesses have been featured across New York Times, Wall Street Journal, Forbes, Fortune, IEEE spectrum among other.

1A - Routing Strategies for 2D/2.5/3D ICs Time: 8:00am - 8:30am

Moderator:

Jianli Chen - Fuzhou Univ.

This session covers various novel techniques in routing. The first paper conducts wire segment routing for 2D global routing. The second one optimizes pin-access in 3D designs. The third paper improves the coupling extraction for heterogeneous 2.5D chiplet-package co-designs. The last one presents an optimization flow for heterogeneous monolithic 3D designs.

- 1A.1 COALA: Concurrently Assigning Wire Segments to Layers for 2D Global Routing Yun-Jhe Jiang, Shao-Yun Fang - National Taiwan Univ. of Science and Technology
- **1A.2** Routability-Driven Pin-Access Optimization for Monolithic 3D IC Designs Run-Yi Wang, **Yao-Wen Chang** - National Taiwan Univ.
- 1A.3 Coupling Extraction and Optimization for Heterogeneous 2.5D Chiplet-Package Co-Design

MD Arafat Kabir - Univ. of Arkansas Dusan Petranovic - Mentor, A Siemens Business Yarui Peng - Univ. of Arkansas

1A.4 Pin-3D: A Physical Synthesis and Post-Layout Optimization Flow for Heterogeneous Monolithic 3D ICs

Sai Surya Kiran Pentapati, Kyungwook Chang - Georgia Institute of Technology Vassilios Gerousis, Rwik Sengupta - Samsung Semiconductor, Inc. Sung Kyu Lim - Georgia Institute of Technology

1B - Electromigration and Circuit Yield: Efficient Verification Techniques

Time: 8:00am - 8:30am

Moderator:

Ing-Chao Lin - National Cheng Kung Univ.

Continuing scaling of integrated circuits has made the active devices as well as interconnections even smaller, which greatly improved circuit performance, while device parameter variation and current density of wires increased significantly. The yield of the manufactured circuit and its long-term reliability have become a major concern in designing circuits. In this session, we discuss efficient electromigration immortality check methods considering current density fluctuation and Joule heating, and a fast Monte Carlo method that uses non-Gaussian adaptive importance sampling technique for accelerating the yield analyses.

*1B.1 Electromigration Checking Using a Stochastic Effective Current Model Adam Issa - Univ. of Toronto Valeriy Sukharev - Mentor, A Siemens Business Farid N. Najm - Univ. of Toronto

- 1B.2 Electromigration Immortality Check considering Joule Heating Effect for Multisegment Wires Mohammadamir Kavousi, Liang Chen, Sheldon X. Tan - Univ. of California, Riverside
- 1B.3 A Non-Gaussian Adaptive Importance Sampling Method for High-Dimensional and Multi-Failure-Region Yield Analysis

Xiao Shi - Univ. of California, Los Angeles **Hao Yan**, Chuwen Li - Southeast Univ. Jianli Chen - Fudan Univ. Longxing Shi - Southeast Univ. Lei He - Univ. of California, Los Angeles & Fudan Univ.



1C - Securing Embedded and IoT Platforms Time: 8:00am - 8:30am

Moderator:

Partha Pande - Washington State Univ.

This session focuses on new approaches to secure embedded and IoT platforms. The first paper explores a crowd-based explosion detection system. The second paper proposes an adaptive anomaly detection in distributed IoT platforms. The third paper explores a Bloom filter-based mechanism for low overhead address space protection in IoT blockchain systems. The last paper proposes a mechanism for protecting embedded neural networks from Trojan attacks.

- 1C.1 A Crowd-Based Explosive Detection System with Two-Level Feedback Sensor Calibration Chengmo Yang, Patrick T. Cronin - Univ. of Delaware Agamyrat Agambayev, Sule Ozev - Arizona State Univ. Ahmet E. Cetin - Univ. of Illinois at Chicago Alex Orailoglu - Univ. of California, San Diego
- 1C.2 IoT-CAD: Context-Aware Adaptive Anomaly Detection in IoT Systems Through Sensor Association Rozhin Yasaei, Felix Hernandez, Mohammad Abdullah Al Faruque - Univ. of California, Irvine
- 1C.3 ABACUS: Address-partitioned Bloom filter on Address Checking for UniquenesS in IoT Blockchain Tianyu Wang - Chinese Univ. of Hong Kong

Wenbin Zhu, Qun Ma, Zhaoyan Shen - Shandong Univ. Zili Shao - Chinese Univ. of Hong Kong

1C.4 CLEANN: Accelerated Trojan Shield for Embedded Neural Networks Mojan Javaheripi, Mohammad Samragh, Gregory Fields, Tara Javidi, Farinaz Koushanfar -Univ. of California, San Diego

Special Session 1D - How Machine Leaning can Reshape Technology, Manufacturability, Performance and Power

Time: 8:00am - 8:30am

Moderators:

Ertugrul Demircan - NXP Semiconductors Mark Johnstone - NXP Semiconductor

Organizers:

Sheldon Tan - Univ. of California Hussam Amrouch - Karlsruhe Institute of Technology

Recently machine learning, especially deep learning is gaining much attention due to the breakthrough performance in various cognitive applications. Machine learning for electronic design automation (EDA) is also gaining significant traction as it provides new computing and optimization paradigms for many challenging design automation problems with complex nature. Today's chip designer and EDA developers faces several many challenges in advanced technologies from technology and physical levels to the circuit and multi-core chip levels such as designing robust circuits with high manufacturability and yield, excessive voltage IR drops, thermally constrained multi-core processor design and runtime thermal/power/reliability management and excessive on-chip power density and efficiency limitations due to fundamental restrictions in voltage scaling etc. Given the complex nature of those EDA problems, this special session focuses on complicated lithography modeling, efficient IR drop estimation, fast full-chip thermal/power modeling, designtechnology co-optimization in advanced technologies and demonstrates the potentials in using latest advances in machine learning to tackle those hard problems towards developing intelligent EDA algorithms. This special session consists of four presentations ranging from machine Learning for VLSI manufacturability and yield, fast machine learning based IR drop estimation, data-driven full-chip thermal/power modeling, machine learning for modeling emerging technologies.

1D.1 Re-examining VLSI Manufacturing and Yield through the Lens of Deep Learning Mohamed Mohamed Baker Alawieh, Wei Ye - Univ. of Taxes at Austin David Z. Pan - Univ. of Texas at Austin

1D.2 Fast IR Drop Estimation with Machine Learning Zhiyao Xie, **Hai Li** - Duke Univ. Xiaoqing Xu - Arm, Ltd. Jiang Hu - Texas A&M Univ. Yiran Chen - Duke Univ.

1D.3 Full-Chip Thermal Map Estimation for Commercial Multi-Core CPUs with Generative Adversarial Learning

Wentian Jin - Univ. of California, Riverside Sheriff Sadiqbatcha - Univ. of California, Riverside Jinwei Zhang, **Sheldon Tan** - Univ. of California, Riverside

1D.4 Modeling Emerging Technologies using Machine Learning: Challenges and Opportunities Florian Klemme, Jannik Prinz, Victor van Santen, Joerg Henkel - Karlsruhe Institute of Technology

Hussam Amrouch - Univ. of Stuttgart

2A - Machining Learning Techniques for Routing and Hotspot Detection

Time: 8:30am - 9:00am

Moderator:

David Chinnery - Mentor, A Siemens Business

This session builds different machining learning frameworks to improve the routability. The first paper presents a hot-spot detection flow through deep layout metric learning. The second one is a plug-in framework to improve the routing. The last one is a detailed router for analog-mixed-signal designs.

- 2A.1 Hotspot Detection via Attention-based Deep Layout Metric Learning Hao Geng, Haoyu Yang, Lu Zhang - Chinese Univ. of Hong Kong Jin Miao - Synopsys, Inc.
 Fan Yang, Xuan Zeng - Fudan Univ.
 Bei Yu - Chinese Univ. of Hong Kong
- PROS: A Plug-in for Routability Optimization applied in the State-of-the-art commercial EDA tool using deep learning
 Jingsong Chen Chinese Univ. of Hong Kong
 Jian Kuang, Guowei Zhao, Dennis J.-H. Huang Cadence Design Systems, Inc.
 Evangeline F.Y. Young Chinese Univ. of Hong Kong
- 2A.3 Toward Silicon-Proven Detailed Routing for Analog and Mixed-Signal Circuits Hao Chen, Keren Zhu, Mingjie Liu, Xiyuan Tang, Nan Sun, David Z. Pan - Univ. of Texas at Austin



2B - Exploring Optimal Mask Patterns Time: 8:30am - 9:00am

Moderator:

Takashi Sato - Kyoto Univ.

Optical proximity correction (OPC) is a process that is widely applied in advanced nodes for manufacturability optimization. It is also the most expensive and difficult process in terms of computational efforts. The first paper in this session tackles this issue with a full chip scale, high-performance and salable OPC system based on deep learning. The second paper proposes an OPC framework that uses a neural network to perform end-to-end pattern prediction and inverse lithography-technology (ILT) based OPC framework. The third paper suggests improved printability through Lammellar directed self-assembly (DSA) with guiding template design.

- 2B.1 DAMO: Deep Agile Mask Optimization for Full Chip Scale Guojin Chen, Wanli Chen, Yuzhe Ma, Haoyu Yang, Bei Yu - Chinese Univ. of Hong Kong
- 2B.2 Neural-ILT: Migrating ILT to Neural Networks for Mask Printability and Complexity Co-optimization Bentian Jiang, Lixin Liu, Yuzhe Ma - Chinese Univ. of Hong Kong Hang Zhang - Cornell Univ. Bei Yu, Evangeline F.Y. Young - Chinese Univ. of Hong Kong
- 2B.3 Guiding Template Design for Lamellar DSA with Multiple Patterning and Self-Aligned Via Process An-Jie Shih, Shao-Yun Fang, Yi-Yu Liu - National Taiwan Univ. of Science and Technology

2C - Safety and Energy Optimizations for Cyber-Physical Systems

Time: 8:30am - 9:00am

Moderator:

Mahdi Nikdast - Colorado State Univ.

This session focuses on optimizing safety-criticality, energy and performance in cyber-physical systems (CPS). The first paper proposes control adaptations for energy-efficient safety guarantees in machine learning-based CPS. The second paper explores the trade-off between the image generation accuracy of a GAN model and the energy consumed in mobile platforms. The third paper lays the foundation for applying probabilistic techniques in safety-critical platforms while ensuring that the functional correctness is not being violated. The last paper proposes an approach for reducing energy and improving performance in 3D resistive memories in a variety of CPS platforms.

- *2C.1 Energy-Efficient Control Adaptation with Safety Guarantees for Learning-Enabled Cyber-Physical Systems Yixuan Wang, Chao Huang, Qi Zhu - Northwestern Univ.
- 2C.2 SETGAN: Scale and Energy Trade-off GANs for Image Applications on Mobile Platforms Nitthilan Kannappan Jayakodi, Jana Doppa, Partha Pratim Pande - Washington State Univ.
- 2C.3 The Safe and Effective Application of Probabilistic Techniques in Safety-Critical Systems Kunal Agrawal, Sanjoy Baruah - Washington Univ. in St. Louis Zhishan Guo - Univ. of Central Florida Jing Li - New Jersey Institute of Technology
- 2C.4 Accelerating 3D Vertical Resistive Memories with Opportunistic Write Latency Reduction Wen Wen, Youtao Zhang, Jun Yang - Univ. of Pittsburgh

Special Session 2D - AIoT: The Powerful Convergence of AI and the IoT - An Industrial Perspective *Time:* 8:30am - 9:00am

Moderator:

Yiran Chen - Duke Univ.

Organizers:

Yiran Chen - Duke Univ. Yung-Hsiang Lu - Purdue Univ.

IoT (Internet of Things) is a disruptive technology that extends data collection to almost everything around us and enables them to react through intelligent data processing. Gartner estimates that the number of connected things will grow to over 20 billion by 2020. With recent innovative network and chip technologies, devices are becoming smarter with increasing compute power, bandwidth, and storage available on the device. This enables intelligent decision making and information transferring through the devices. Insights derived from data generated by IoT devices power new business scenarios and ensure long term success of existing business. Major IT solution providers have been investing in building IoT data platform to support customers to develop IoT solutions in different industry sectors such as smart cities, manufacturing, health care and transportation. These business scenarios impose both technical challenges and opportunities in building intelligent cloud and edge solutions.

The proposed special session includes three talks from both industry and academia, focusing on giving an integrated view about AIoT (AI for IoT) across three different levels – Devices, Software/ Hardware Codesign, and System. The topics are also carefully selected to cover the areas that either are fully covered by regular submissions to ICCAD or the opinions from industry are not fully expressed in the past. All the speakers also have 10-20 years' experience in the relevant areas.

2D.2 Challenges for Building a Cloud Native Scalable and Trustable Multi-tenant AloT Platform

Jinjun Xiong - IBM Corp. Huamin Chen - Red Hat, Inc.

2D.3 Ambient Intelligence and Privacy

Vikram Tank, Alison Lentz, Carlos Mendonca, Marco Zamarato - Google, Inc.

3A - Brain-inspired, Bio-engineering, and Emerging Computing

Time: 9:00am - 9:30am

Moderator:

Debashis Sahoo - Univ. of California, San Diego

The emerging field of brain-inspired computing and bio-engineering computing has the potential to revolutionize the technology world. This session will showcase the state-of-the-art developments relevant to this fast-developing world of emerging computing. The first paper proposes an instorage computing (ISC) solution that performs hyperdimensional computing (HDC). The second paper presents the near-data-processing accelerator for *k*-mer counting. The third paper develops a practical synthesis flow called PathDriver for the design automation of microfluidic biochips. The fourth paper introduces a Cascaded Echo State Network (CESN) to accelerate the detection efficiency and increase the robustness for MIMO-OFDM systems.

 3A.1 THRIFTY: Training with Hyperdimensional Computing across Flash Hierarchy Saransh Gupta, Justin L. Morris - Univ. of California, San Diego & San Diego State Univ. Mohsen Imani - Univ. of California, San Diego & Univ. of California, Irvine Ranganathan Ramkumar, Jeffrey Yu, Aniket Tiwari - Univ. of California, San Diego Baris Aksanli - San Diego State Univ. Tajana Rosing - Univ. of California, San Diego

3A.2 NEST: DIMM based Near-Data-Processing Accelerator for K-mer Counting Wenqin Huangfu - Univ. of California, Santa Barbara Krishna T. Malladi - Samsung Semiconductor, Inc. Shuangchen Li, Peng Gu, Yuan Xie - Univ. of California, Santa Barbara

3A.3 PathDriver: A Path-Driven Architectural Synthesis Flow for Continuous-Flow Microfluidic Biochips

Xing Huang - Tech. Univ. of Munich Youlin Pan - Fuzhou Univ. Li Zhang, Bing Li - Tech. Univ. of Munich Wenzhong Guo - Fuzhou Univ. Tsung-Yi Ho - National Tsing Hua Univ. Ulf Schlichtmann - Tech. Univ. of Munich

3A.4 Detection through Deep Neural Networks: A Reservoir Computing Approach for MIMO-OFDM Symbol Detection

Kangjun Bai, Lingjia Liu, Zhou Zhou, **Yang (Cindy) Yi** - Virginia Polytechnic Institute and State Univ.

3B - Novel Techniques for Improving Reliability and Manufacturability

Time: 9:00am - 9:30am

Moderator:

Yu Cao - Arizona State Univ.

CMOS scaling has made circuit design as well as mask layout design extremely difficult. The exploration covering broad ranges of techniques, from traditional CAD algorithms to machine learning techniques is actively carried out. The first paper in this session applies a feed-forward neural network for estimating aged gate delays of standard cells in a design library. The second paper proposes to apply generative learning models, by learning the inherent distribution of a given set of layouts, to the synthesis of layout patterns and their legalization. The third paper proposes an algorithm for accurate layout pattern matching through line sweep.

3B.1 Aadam: A Fast, Accurate, and Versatile Aging-Aware Cell Library Delay Model using Feed-Forward Neural Network

Seyed Milad Ebrahimipour - Shahid Bahonar Univ. Behnam Ghavami - Simon Fraser Univ. Hamid Mousavi - Shahid Bahonar Univ. Mohsen Raji - Shiraz Univ. Zhenman Fang, Lesley Shannon - Simon Fraser Univ.

3B.2 Layout Pattern Generation and Legalization with Generative Learning Models Xiaopeng Zhang - Chinese Univ. of Hong Kong James Shiely - Synopsys, Inc. Evangeline F.Y. Young - Chinese Univ. of Hong Kong

3B.3 An Algorithm for Rule-based Layout Pattern Matching Sheng-Hao Wang, Yen-Jong Chen, Ting-Chi Wang - National Tsing Hua Univ. Oscar Chen - AnaGlobe Technology, Inc.



3C - Secure Architectures and Systems Design Time: 9:00am - 9:30am

Moderator:

Michel Kinsy - Texas A&M Univ.

This session focuses on the design of secure architectures to mitigate among others cache-based side-channel attacks, secure embedded systems explorations using RISC-V and ARM ISAs, tightly integrated post-quantum algorithms accelerators, and securing neural network accelerators against certain classes of attack.

- 3C.1 RIMI: Instruction-level Memory Isolation for Embedded Systems on RISC-V Haeyoung Kim, Jinjae Lee, Derry Pratama, Asep Muhamad Awaludin, Howon Kim, Donghyun Kwon - Pusan National Univ.
- 3C.2 Efficient Hardware/Software Co-Design for Post-Quantum Crypto Algorithm SIKE on ARM and RISC-V based Microcontrollers Debapriya Basu Roy, Tim Fritzmann - Tech. Univ. of Munich Georg Sigl - Technische Univ. München
- 3C.3 Hybrid-Shield: Accurate and Efficient Cross-Layer Countermeasure for Run-Time Detection and Mitigation of Cache-Based Side-Channel Attacks Han Wang - Univ. of California, Davis Hossein Sayadi, Avesta Sasan, Setareh Rafatirad, Houman Homayoun - George Mason Univ.
- 3C.4 Concurrent Weight Encoding-based Detection for Bit-Flip Attack on Neural Network Accelerators Qi Liu. Wujie Wen - Lehigh Univ.

Yanzhi Wang - Northeastern Univ.



Embedded Tutorial 3D - Hardware/Software Co-Design for Machine Learning in Medicine *Time: 9:00am - 9:30am*

Moderator:

Wujie Wen - Lehigh Univ.

Organizer:

Jingtong Hu - Univ. of Pittsburgh

Machine learning in healthcare is one area which is seeing rapid technology development and acceptance in the healthcare industry. Machine Learning (ML) in healthcare helps to analyze thousands of different data points and suggest outcomes, provide timely risk scores, precise resource allocation, and has many other applications. The increasingly growing number of applications of machine learning in healthcare allows us to glimpse at a future where data, analysis, and innovation work hand-in-hand to help countless patients without them ever realizing it. Soon, it will be quite common to find ML-based applications embedded with real-time patient data available from different healthcare systems, thereby increasing the efficacy of new treatment options which were unavailable before. In this tutorial, we will invite three speakers to talk about the latest development of applications of machine learning in healthcare, and how they stand to change the way we visualize the healthcare industry in the future.

In the first talk, the speaker will present a neural architecture search technique to automatically generate personalized deep neural networks for life-threatening ventricular arrhythmias (VA) detection in implantable cardioverter defibrillators. In the second talk, the speaker will present novel application of CNN in mobile devices in medical domain. In the third talk, the speaker will introduce new hardware platforms and neural network architecture design co-exploration techniques for fast and accurate magnetic resonance imaging (MRI) in various cardiac interventions.

3D.1 Personalized Deep Learning for Ventricular Arrhythmias Detection on Medical IoT Systems

Zhenge Jia, Zhepeng Wang - Univ. of Pittsburgh Feng Hong, Lichuan Ping - Singular Medical Yiyu Shi - Univ. of Notre Dame **Jingtong Hu** - Univ. of Pittsburgh

3D.2 New Passive and Active Attacks on Deep Neural Networks in Medical Applications Cheng Gongye, Hongjia Li, Xiang Zhang - Northeastern Univ. Majid Sabbagh -Geng Yuan, Xue Lin, Thomas Wahl, Yunsi Fei - Northeastern Univ.

3D.3 Towards Cardiac Intervention Assistance: Hardware-aware Neural Architecture Exploration for Real-time 3D Cardiac Cine MRI Segmentation

Dewen Zeng, Weiwen Jinag, Tianchen Wang - Univ. of Notre Dame Xiaowei Xu - Guangdong General Hospital Haiyun Yuan - Harvard Medical School Meiping Huang, Jian Zhuang - Guangdong General Hospital Jingtong Hu - Univ. of Pittsburgh **Yiyu Shi** - Univ. of Notre Dame

MONDAY, NOVEMBER 2



Delivering Improved Design Performance by Applying Machine Learning to EDA

Time: 9:30am - 10:00am

Speaker:

Dr. Venkat Thanvantri

Thank you to our Sponsor:



As advanced process nodes become ever smaller, design performance

goals always seem to increase, not just for clock frequency, but also power and area. To meet these challenging requirements, Cadence continually research new, innovative, technologies which will help deliver the latest high performance silicon devices. Machine learning is a good example, and shows great potential to further improve digital design automation. During this paper Cadence will discuss how Machine Learning can being used within digital implementation tools, and as part of flow optimization, to deliver better productivity and design performance

Bio: Dr Venkat Thanvantri is VP of R&D at Cadence where he leads the AI/ML development for the Digital and Signoff Products. Venkat holds a PhD from University of Florida and a Master's from Indian Institute of Sciences. He has over 20 years of experience in developing, managing, and deploying multiple EDA tools in the areas of timing, extraction, characterization, power and place & route.

ACM Student Research Competition at ICCAD 2020 Time: 9:30am - 11:30am

The ACM Student Research Competition (SRC), sponsored by Microsoft, offers a unique forum for undergraduate and graduate students to present their original research at well-known ACM sponsored and co-sponsored conferences before a panel of judges and attendees. The ICCAD-edition of SRC features the following students and topics which are presented within three parallel sessions:

Session 1:

- Chuangtao Chen: Optimally Approximated Floating-Point Multiplier
- Sergi Alcaide, Leonidas Kosmidis, Carles Hernandez and Jaume Abella: Scheduling policies to enable GPUs for Critical Real-Time Automotive Systems
- Alejandro Calderón and Leonidas Kosmidis: GMAI: An Open Source Tool for Inspecting the Internals of GPU Memory Allocators
- Ivan Rodiguez-Ferrandez and Leonidas Kosmidis: An On-board Algorithm Implementation on an Embedded GPU: A Space Case Study
- Marc Benito and Leonidas Kosmidis: Evaluation of Graphics-based General Purpose Computation Solutions for Safety Critical Systems: An Avionics Case
- Namiko Matsumoto, Anthony Thomas and Tajana Rosing: Hyperdimensional Computing and Spectral Learning
- Anish Krishnakumar: An Intelligent Scheduling Paradigm for Heterogeneous Systems-on-Chip
- Chen Chen, Zirui Tao and Joshua San Miguel: Bufferless NoCs with Scheduled Deflection Routing information
- Mahabubul Alam and Swaroop Ghosh: Analysis and Optimization Methodologies for Quantum Approximate Optimization Algorithm
- Yuan-Hung Tsai, Jie-Hong R. Jiang and Chiao-Shan Jhang: Bit-Slicing the Hilbert Space: Scaling Up Accurate Quantum Circuit Simulation to a New Level
- Thomas Grurl and Robert Wille: Realistic and Efficient Simulation of Quantum Circuits Using
 Decision Diagrams

Session 2:

- Hao Geng and Bei Yu: Feature Learning in VLSI CAD
- Mingfei Yu and Masahiro Fujita: Parallel Scheduling Modern Deep Learning Implementations
- Bentian Jiang AIDA: Artificial Intelligence and Design Automation with Case Study on Layoutlevel Optimizations
- Sumit K. Mandal: Towards Efficient Hardware Architecture with Optimized Interconnect for DNNs
- Jiaqi Gu and David Z. Pan: Light in Artificial Intelligence: Efficient Neuromorphic Computing with Optical Neural Networks
- Mojan Javaheripi, Mohammad Samragh and Farinaz Koushanfar: Accelerated Shields for Safe and Robust Embedded Deep Learning
- Aryan Chaudhary and Saikat Mukhopadhyay: Artificial Intelligence in Health Sector

MONDAY, NOVEMBER 2

- Zihao Yuan and Ayse Coskun: Energy-Efficient Cooling Optimization Framework via Deep Learning
- Jun-Shen Wu, Chi-En Wang and Ren-Shuo Liu: Value-Aware Error Detection and Correction for SRAM Buffersin Low-Bitwidth, Floating-Point CNN Accelerators

Session 3:

- Xing Zhang and Xiaotong Cui: Use Graph-theoretic Models to Build and Optimize Trustworthy SoCs
- Lilas Alrahis and Hani Saleh: Novel Attack and Defense Strategies for Enhanced Logic Locking Security
- Debayan Das: Generic Low-overhead Electromagnetic and Power Side-Channel Attack Protection through Ground-Up Root-cause Analysis
- Mark Tressler and Kevin Sipple: A Flexible Framework for Attack and Defense Optimality in Split Manufacturing
- Nimisha Limaye: Security Assessment of Scan Locking Techniques for Design IP Protection
- Nithyashankari Gummidipoondi Jayasankaran, Adriana Sanabria-Borbon, Edgar Sanchez-Sinencio, Jiang Hu and Jeyavijayan Rajendran: Analog IP Protection and Evaluation
- Ai Quoc Dao: Gate-level Verification and ECO for Functional Safety
- Muhammad Usama Sardar: Formal Foundations for Remote Attestation in Intel SGX
- Shu-Ting Cheng: NBTI-Aware Heterogeneous Multi-Core System Design: An Energy-Efficient Standby-Sparing System Approach
- Alvaro Jover-Alvarez and Leonidas Kosmidis: Evaluation of the Computational Capabilities of High-Performance Heterogeneous Embedded Platforms for Safety Critical Systems
- Shreyas Kolala Venkataramanaiah and Jae-Sun Seo FPGA-based Energy-Efficient CNN Training
 Accelerator







Microsoft

TUESDAY SCHEDULE

6:30 - 7:00am

4A: New Techniques for NoC Design and Optimization to Beat Handcrafting

4B: Deep Learning Acceleration: Bridging the Gap Between Software and Hardware

4C: EDA for Security

Special Session 4D: Computer-Aided Analog and Mixed-Signal Design from System to Layout

7:00 - 8:00am ·····

IEEE CEDA Keynote: Interplay of Design and Operation to Enable Adaptive and Robust Cyber Physical (Production) Systems

Birgit Vogel-Heuser - Tech. Univ. of Munich

8:00 - 8:30am

5A: Integrating Novel Memory Technologies to Optimize System Performance or Area

5B: DNN Acceleration on GPGPU and FPGA Platforms

5C: Side Channel Attacks and Defenses

Special Session 5D: 2020 CAD Contest at ICCAD

8:30 - 9:00am

6A: How to Exploit FPGA Platforms for Application-Specific Acceleration

6B: Safeguarding Deep Learning Towards Secure and Robust Artificial Intelligence

6C: Logic Locking: Arms Race

Special Session 6D: Design Automation for Autonomous Systems: Uncertainty-Aware Behavior Assurance

TUESDAY SCHEDULE

9:00 - 9:30am

7A: Emerging Technologies and Innovative Applications in Synthesis 7B: Efficient Deep Learning Inference and Training Towards Green AI

7C: In-Memory Computing for Hardware Acceleration

Special Session 7D: Opensource Tools and Platforms for Agile Development of Specialized Architectures

9:30 - 10:00am8A: Cross-layer Design for Timing Resilient Embedded Systems

8B: ReRAM-based Accelerators for Neural Networks

8C: Safety and Security Validation

Special Session 8D: Taking Open-Source EDA to the Next Level: From Research to Production IC Design



4A - New Techniques for NoC Design and Optimization to Beat Handcrafting

Time: 6:30am - 7:00am

Moderator:

Theocharis Theocharides - Univ. of Cyprus

This session covers new EDA techniques for NoC design and optimization. The first paper proposes a new NoC synthesis tool to create custom NoC designs optimized for power, performance and area that outperform handcrafted designs using behavior specifications and relying on traffic conflict graphs and combinatorial optimization techniques. The second paper presents a novel analytical approach to estimate the end-to-end latency of priority-aware NoC designs with deflection routing under different traffic types. The third paper presents a new EDA-based approach for wavelength routed optical NoC designs to minimize laser power.

4A.1 Automated Synthesis of Custom Networks-on-Chip for Real World Applications Anup Gangwar, Nitin Kumar Agarwal, Ravishankar Sreedharan, Ambica Prasad, Sri Harsha Gade - Arm, Ltd. Zheng Xu - Consultant

4A.2 Performance Analysis of Priority-Aware NoCs with Deflection Routing under Traffic Congestion

Sumit K. Mandal, Anish Krishnakumar - Univ. of Wisconsin, Madison Raid Ayoub, Michael Kishinevsky - Intel Corp. Umit Y. Ogras - Univ. of Wisconsin, Madison

4A.3 PSION 2: Optimizing Physical Layout of Wavelength-Routed ONoCs for Laser Power Reduction

Alexandre Truppel, Tsun-Ming Tseng, Ulf Schlichtmann - Tech. Univ. of Munich

4B - Deep Learning Acceleration: Bridging the Gap Between Software and Hardware

Time: 6:30am - 7:00am

Moderator:

Andrea Calimera - Politecnico di Torino

The ubiquitous adoption of AI technologies passes through an efficient implementation of Deep Learning. While algorithmic advances enabled highly accurate Deep Neural Networks (DNNs), there is still an urgent need to push down the cost for processing them. This session proposes four papers dealing with the acceleration of DNNs and their training, introducing new HW/SW design & optimization strategies where energy and throughput are the main objectives. The first paper describes GAMMA, a domain-specific genetic algorithm for the optimal mapping of the DNN layers into spatial neural accelerators. The design of a Convolutional Neural Networks (CNNs) accelerator featuring logarithmic data representation and three-dimensional organization of tightly coupled processing elements is the focus of the second paper. In contrast, the third paper proposes a many-core chip with a specialized Network-on-Chip for efficient Deep Reinforcement Learning (DRL). The fourth paper introduces an architecture for a new approximate DRAM refresh mechanism, which achieves high energy efficiency while not affecting the quality of the training stage.

- 4B.1 GAMMA: Automating the HW Mapping of DNN Models on Accelerators via Genetic Algorithm Sheng-Chun Kao, Tushar Krishna - Georgia Institute of Technology
- 4B.2 NeuroMAX: A High Throughput, Multi-Threaded, Log-Based Accelerator for Convolutional Neural Networks Mahmood Azhar Qureshi, Arslan Munir - Kansas State Univ.
- 4B.3 A Many-Core Accelerator Design for On-Chip Deep Reinforcement Learning Ying Wang - Chinese Academy of Sciences & State Key Laboratory of Computer Architecture Mengdi Wang - Chinese Academy of Sciences & Univ. of Chinese Academy of Sciences Bing Li - Capital Normal Univ. Huawei Li - Chinese Academy of Sciences & State Key Laboratory of Computer Architecture Xiaowei Li - Chinese Academy of Sciences & State Key Laboratory of Computer Architecture

 4B.4 DRAMA: An Approximate DRAM Architecture for High-performance and Energy-efficient Deep Training System
 Duy-Thanh Nguyen, Chang-Hong Min - Kyung Hee Univ.
 Nhut-Minh Ho - National Univ. of Singapore
 Ik-Joon Chang - Kyung Hee Univ.

4C - EDA for Security Time: 6:30am - 7:00am

Moderator:

Jeyavijayan Rajendran - Texas A&M Univ.

This session covers a variety of EDA for security research works focusing on hardware security assessment and defense techniques. The first paper presents a CAD framework to assess the learnability of physical unclonable functions automatically. The second paper develops a method for generating synthetic hardware security benchmarks. The third paper introduces a benchmark suite for laser fault injection attacks. The fourth paper explores Boolean masking of neural network hardware design to defend against power side-channel attacks.

- 4C.1 PUF-G: A CAD Framework for Automated Assessment of Provable Learnability from Formal PUF Representations Durba Chatterjee, Debdeep Mukhopadhyay, Aritra Hazra - Indian Institute of Technology Kharagpur
- 4C.2 Adaptable and Divergent Synthetic Benchmark Generation for Hardware Security Sarah Amir, Domenic Forte Univ. of Florida
- 4C.3 Laser Attack Benchmark Suite Burin Amornpaisannon, Andreas Diavastos, Li-Shiuan Peh, Trevor E. Carlson - National Univ. of Singapore
- 4C.4 BoMaNet: Boolean Masking of an Entire Neural Network Anuj Dubey - North Carolina State Univ. Rosario Cammarota - Intel Corp. & IEEE Avdin Avsu - North Carolina State Univ.



Special Session 4D - Computer-Aided Analog and Mixed-Signal Design from System to Layout *Time: 6:30am - 7:00am*

Moderators:

Mark Po-Hung Lin - National Chiao Tung Univ. Sachin Sapatnekar - Univ. of Minnesota

Organizers:

Mark Po-Hung Lin - National Chiao Tung Univ. Sachin Sapatnekar - Univ. of Minnesota

Analog and mixed-signal (AMS) integrated circuits (ICs) are essential in many system-on-chip (SoC) and internet-of-thing (IoT) applications. Although design automation for AMS ICs has been researched for decades, modern AMS design still requires much designers' effort with limited qualified computer-aided design (CAD) tools. Consequently, it usually takes a long design cycle from system to layout design. The proposed special session addresses the state-of-the-art computer-aided AMS design, which consists of four presentations on current progress and new advancement. The topics cover modeling and simulation of statistical characteristics for an AMS system, structural synthesis and modeling of various operational amplifiers, a newly developed open-source analog layout generator and its roadmap, and a layout synthesis methodology through learning and migration.

- 4D.1 Modeling and Simulation of NAND Flash Memory Sensing Systems with Cell-to-Cell Vth Variations Nayoung Choi - Seoul National Univ., Samsung Electronics Jaeha Kim - Seoul National Univ.
- 4D.2 Structural Synthesis of Operational Amplifiers Based on Functional Block Modeling Inga Abel, Helmut Graeb - Tech. Univ. of Munich

4D.3 The ALIGN Open-Source Analog Layout Generator: v1.0 and Beyond Tonmoy Dhar, Kishor Kunal - Univ. of Minnesota Yaguang Li, Yishuang Lin - Texas A&M Univ. Meghna Madhusudan, Jitesh Poojary, Arvidd K. Sharma - Univ. of Minnesota Steven M. Burns - Intel Corp. Ramesh Harjani - Univ. of Minnesota Jiang Hu - Texas A&M Univ. Parijat Mukherjee, Soner Yaldiz - Intel Corp. Sachin Sapatnekar - Univ. of Minnesota

4D.4 Achieving Analog Layout Integrity through Learning and Migration Mark Po-Hung Lin, Hao-Yu Chi, Abhishek Patyal - National Chiao Tung Univ. Zheng-Yao Liu, Jun-Jie Zhao - National Chung Cheng Univ. Chien-Nan Jimmy Liu, Hung-Ming Chen - National Chiao Tung Univ.

TUESDAY, NOVEMBER 3



Keynote IEEE CEDA: Interplay of Design and Operation to Enable Adaptive and Robust Cyber Physical (Production) Systems

Time: 7:00am - 8:00am

Speaker: Birgit Vogel-Heuser - Tech. Univ. of Munich

Data-Driven Model and System Evolution enable adaptive and robust Cyber Physical (Production) Systems for example by continuously increasing simulation accuracy during design and a more coarse grained simulation during operation to fulfill real-time requirements. Capturing and analyzing data throughout the entire life cycle of a CPPS will allow drawing conclusions about the benefits and weaknesses of CPPS designs as well as its configuration during operation. The status and future challenges of design automation and optimization for CPPSs will be covered.

Biography: Prof. Vogel-Heuser received her Dipl. Ing. degree in electrical engineering in 1987 and her Dr.-Ing. degree in mechanical engineering in 1990 from the RWTH Aachen, Germany. She acquired industrial experience over ten years, including a position as manufacturing director for the Siempelkamp Group. After various professorship positions in Hagen, Wuppertal, and Kassel, she was appointed to the Chair of Automation and Information Systems at TUM in 2009. She is speaker of the DFG Collaborative Research Centre 768 "Managing cycles in innovation processes", member of the coordination board of the DFG Priority Program 1593 "Design for Future" and member of the National Academy of Science and Engineering (acatech).

5A - Integrating Novel Memory Technologies to Optimize System Performance or Area *Time: 8:00am - 8:30am*

Moderator:

Marina Zapater - Univ. of Applied Sciences and Arts Western Switzerland

This session presents different approaches to exploit novel memory technologies for new applications to optimize performance, area or resilience at the system level. The first paper proposes a genome read mapping accelerator using approximate Ternary Content Addressable Memories (TCAM). The second paper presents Automatic-SSD, a new controller design for new non-volatile memories, such as phase change or 3D Xpoint, that can reduce latency and power consumption due to currently used firmware for such memories. The third paper proposes a novel machine learning technique using a small artificial neural network to dynamically partition the SSD cache based on an analysis of the level of reuse within each stream. The fourth paper in this session presents the benefits of a small on-chip ECC cache to improve performance during the insertion and deletion of entries in contrast to the verify-after-write approach used today to tackle stuck-at faults in phase change memories.

- 5A.1 Seed-and-Vote based In-Memory Accelerator for DNA Read Mapping Ann Franchesca Laguna - Univ. of Notre Dame Hasindu Gamaarachchi - Univ. of New South Wales Xunzhao Yin - Zhejiang Univ. Michael T. Niemier - Univ. of Notre Dame Sridevan Parameswaran - Univ. of New South Wales Xiaobo Sharon Hu - Univ. of Notre Dame
 5A.2 Automatic-SSD: Full Hardware Automation over New Memory for High Performance
- 5A.2 Automatic-SSD: Full Hardware Automation over New Memory for High Performance and Energy Efficient PCIe Storage Cards Gyuyoung Park, Myoungsoo Jung - Korea Advanced Institute of Science and Technology
- 5A.3 MLCache: A Space-Efficient Cache Scheme based on Reuse Distance and Machine Learning for NVMe SSDs
 Weiguang Liu, Jinhua Cui, Junwei Liu, Laurence T. Yang - Huazhong Univ. of Science & Technology
- 5A.4 ECC Cache: A Lightweight Error Detection for Phase-Change Memory Stuck-At Faults Chao Zhang, Khaled Abdelaal, Angel Chen, Xinhui Zhao, Wujie Wen, Xiaochen Guo - Lehigh Univ.

5B - DNN Acceleration on GPGPU and FPGA Platforms *Time: 8:00am - 8:30am*

Moderator:

Tinoosh Mohsenin - Univ. of Maryland, Baltimore County

GPGPU and FPGA have been widely used to accelerate computations of Deep Neural Networks (DNNs). This session introduces three papers tackling state-of-the-art challenges in DNN acceleration on GPGPU and FPGA platforms: The first paper presents a technique to accelerate graph convolutional neural network training on GPGPU. The second paper introduces a framework to model and explore DNN accelerator design on FPGA. The third paper discusses a systematic optimization method to encode, model and architect FPGA acceleration of spiking neural networks.

5B.1 fuseGNN: Accelerating Graph Convolutional Neural Network Training on GPGPU Zhaodong Chen, Mingyu Yan - Univ. of California, Santa Barbara & Univ. of California, Santa Barbara Maohua Zhu, Lei Deng - Univ. of California, Santa Barbara Guoqi Li - Tsinghua Univ. Shuangchen Li - Alibaba Group Yuan Xie - Univ. of California, Santa Barbara

5B.2 DNNExplorer: A Framework for Modeling and Exploring a Novel Paradigm of FPGAbased DNN Accelerator Xiaofan Zhang, Hanchen Ye - Univ. of Illinois at Urbana-Champaign Junsong Wang, Yonghua Lin - E-Vision Al Jinjun Xiong - IBM Research Wen-mei Hwu, Deming Chen - Univ. of Illinois at Urbana-Champaign

5B.3 Encoding, Model, and Architecture: Systematic Optimization for Spiking Neural Network in FPGAs

Haowen Fang, Zaidao Mei, Amar Shrestha, Ziyi Zhao, Yilan Li, Qinru Qiu - Syracuse Univ.

5C - Side Channel Attacks and Defenses *Time: 8:00am - 8:30am*

Moderator:

Hossein Sayadi - California State Univ. Long Beach

This session covers side-channel attack and defense techniques under a variety of hardware security scenarios. The first paper introduces two new information leakage attacks targeting the FPGA routing and logic elements. The second paper develops a quantitative defense framework to mitigate the attacks against power distribution networks on multi-tenant FPGAs. The third paper proposes an online defense mechanism to detect voltage drops due to power side-channel attacks in power grids. The fourth paper presents a systematic methodology to develop fault templates of Boolean circuits that can attack a popular defense against side-channel analysis.

- 5C.1 Information Leakage from FPGA Routing and Logic Elements Ilias Giechaskiel - Independent Researcher Jakub Szefer - Yale Univ.
- 5C.2 A Quantitative Defense Framework against Power Attacks on Multi-tenant FPGA Yukui Luo, Xiaolin Xu - Northeastern Univ.
- 5C.3 Power Side Channel Attack Analysis and Detection Navyata Gattu, Mohammad Nasim Imtiaz Khan, Asmit De, Swaroop Ghosh - Pennsylvania State Univ.
- 5C.4 Faultless to a Fault? The Case of Threshold Implementations of Crypto-systems vs Fault Template Attacks Debdeep Mukhopadhyay - Indian Institute of Technology Kharagpur



Special Session 5D - 2020 CAD Contest at ICCAD Time: 8:00am - 8:30am

Moderators:

Tsung-Wei Huang - Univ. of Utah Mark Po-Hung Lin - National Chiao Tung Univ.

Organizers:

Ing-Chao Lin - National Cheng Kung Univ. Ulf Schlichtmann - Technical Univ. of Munich Tsung-Wei Huang - Univ. of Utah Mark Po-Hung Lin - National Chiao Tung Univ.

The CAD Contest at ICCAD (https://iccad-contest.org/2020/) is a challenging, multi-month, research & development competition, focusing on advanced, real-world problems in the field of Electronic Design Automation (EDA). Contestants can participate in one or more problems provided by EDA/IC industry. The winners will be awarded at an ICCAD special session dedicated to this contest. Since 2012, the CAD Contest at ICCAD has been attracting more than a hundred teams per year, fostering productive industry-academia collaborations, and leading to hundreds of publications in top-tier conferences and journals. The contest keeps enhancing its impact and boosts EDA research.

5D.1 Overview of 2020 CAD contest at ICCAD Ing-Chao Lin - National Cheng Kung Univ. Ulf Schlichtmann - Tech. Univ. of Munich

Ulf Schlichtmann - Iech. Univ. of Munich Tsung-Wei Huang - Univ. of Utah Mark Po-Hung Lin - National Chiao Tung Univ.

- 5D.2 ICCAD-2020 CAD Contest in X-value Equivalence Checking and Benchmark Suite Jacky (Chih-Jen) Hsu, Rocky (Chi-An) Wu, Ching-Yi Huang, Kei-Yong Khoo - Cadence Design Systems, Inc.
- 5D.3 ICCAD-2020 CAD Contest in Routing with Cell Movement Kai-Shun Hu, Ming-Jen Yang, Tao-Chun Yu, Guan-Chuen Chen - Synopsys, Inc.
- 5D.4 Problem C: GPU Accelerated Logic Re-simulation Yanqing Zhang, Haoxing Ren, Ben Keller, Brucek Khailany - Nvidia Corp.

5D.5 DATC RDF-2020: Strengthening the Foundation for Academic Research in IC Physical Design

Jianli Chen - Fudan Univ. & Fuzhou Univ. **Iris Hui-Ru Jiang** - National Taiwan Univ. Jinwook Jung - IBM Research Andrew B. Kahng - Univ. of California, San Diego Victor N. Kravets - IBM Research Yi-Lang Li, Shih-Ting Lin - National Chiao Tung Univ. Mingyu Woo - Univ. of California, San Diego

6A - How to Exploit FPGA Platforms for Application-Specific Acceleration *Time: 8:30am - 9:00am*

Moderator:

Marco Santambrogio - Polytechnic Univ. of Milan

This session covers new approaches to exploit FPGA platforms in the context of applicationspecific acceleration and performance improvement. The first paper presents LegoGNN, a new framework that generates and optimizes automatically graph network accelerators on FPGA platforms. The second paper proposes SuSy, a new framework to generate FPGA-based implementations of systolic arrays using uniform recurrence equations. The third paper presents an FPGA accelerator with high bandwidth HBM2 memory for training CNNs in a low batch number to improve performance and energy efficiency.

6A.1 DeepBurning-GL: an Automated Framework for Generating Graph Neural Network Accelerators

Shengwen Liang - Chinese Academy of Sciences & Univ. of Chinese Academy of Sciences Cheng Liu - Chinese Academy of Sciences & Univ. of Chinese Academy of Sciences Ying Wang - Chinese Academy of Sciences & Univ. of Chinese Academy of Sciences Huawei Li - Chinese Academy of Sciences & Univ. of Chinese Academy of Sciences Xiaowei Li - Chinese Academy of Sciences & Univ. of Chinese Academy of Sciences

6A.2 SuSy: A Programming Model for Productive Construction of High-Performance Systolic Arrays on FPGAs

Yi-Hsiang Lai - Cornell Univ. Hongbo Rong - Intel Corp. Size Zheng - Peking Univ. Weihao Zhang - Tsinghua Univ. Xiuping Cui, Yunshan Jia - Peking Univ. Jie Wang - Univ. of California, Los Angeles Brendan Sullivan, Zhiru Zhang - Cornell Univ. Yun (Eric) Liang - Peking Univ. Youhui Zhang - Tsinghua Univ. Jason Cong - Univ. of California, Los Angeles Nithin George, Jose Alvarez, Christopher J Hughes, Pradeep K. Dubey - Intel Corp.

6A.3 FPGA-based Low-Batch Training Accelerator for Modern CNNs Featuring High Bandwidth Memory

Shreyas Kolala Venkataramanaiah, Han-Sok Suh, Shihui Yin - *Arizona State Univ*. Eriko Nurvitadhi, Aravind Dasu - *Intel Corp*. Yu Cao, Jae-sun Seo - *Arizona State Univ*.

6B - Safeguarding Deep Learning Towards Secure and Robust Artificial Intelligence *Time: 8:30am - 9:00am*

Moderator:

Wei Yan - Clarkson Univ.

Despite their versatile capabilities and widespread applications, deep learning models are known to be susceptible to adversarial attacks and accuracy degradations, compromising the reliability of the artificial intelligence systems they enable. In this session, we will introduce several intelligent techniques to deal with such challenges: The first paper presents a SW/HW co-design approach to achieve anomalous feature suppression against bit-error propagation; followed by an algorithmic approach detailed in the second paper that leverages the Hessian of the weight matrix to identify and protect sensitive parameters against process variations in emerging non-volatile memory-based Processing-in-Memory (PIM) architecture. The final paper of the session devises a lightweight implementation to embed XOR cipher to protect DNN models inside Compute-in-Memory (CIM) SRAM architecture.

- 6B.1 Just Say Zero: Containing Critical Bit-Error Propagation in Deep Neural Networks With Anomalous Feature Suppression Elbruz Ozen, Alex Orailoglu - Univ. of California, San Diego
- 6B.2 Hessian-Driven Unequal Protection of DNN Parameters for Robust Inference Saurabh Dash, Saibal Mukhopadhyay - Georgia Institute of Technology
- 6B.3 XOR-CIM: Compute-in-Memory SRAM Architecture with Embedded XOR Encryption Shanshi Huang, Hongwu Jiang, Xiaochen Peng, Wantong Li, Shimeng Yu - Georgia Institute of Technology

6C - Logic Locking: Arms Race Time: 8:30am - 9:00am

Moderator:

Xiaolin Xu - Northeastern Univ.

Logic locking techniques aim to address the important security concerns in the IC supply chain, such as piracy. In this session, we have three papers on the recent developments of logic locking research. The first paper introduces a canonical prune-and-SAT attack for breaking the stateof-the-art routing-based obfuscation techniques. The second paper discusses a neural network guided SAT attack against logic locked complex structures. The third paper demonstrates two SAT modeling techniques that can speed up the attacks on logic locking.

- **6C.1** InterLock: An Intercorrelated Logic and Routing Locking Hadi Mardani Kamali, Kimia Zamiri Azar - George Mason Univ. Houman Homayoun - Univ. of California, Davis Avesta Sasan - George Mason Univ.
- 6C.2 NNgSAT: Neural Network guided SAT Attack on Logic Locked Complex Structures Kimia Zamiri Azar, Hadi Mardani Kamali - George Mason Univ. Houman Homayoun - Univ. of California, Davis Avesta Sasan - George Mason Univ.
- 6C.3 Modeling Techniques for Logic Locking Joseph P. Sweeney, Marijn J.H. Heule, Lawrence Pileggi - Carnegie Mellon Univ.

TUESDAY, NOVEMBER 3

Special Session 6D - Design Automation for Autonomous Systems: Uncertainty-Aware Behavior Assurance

Time: 8:30am - 9:00am

Moderator:

Xin Li - Duke Univ.

Organizer:

Shiyan Hu - Univ. of Southampton

Autonomous systems are self-governed and self-adaptive systems that comply with high assurance correctness and safety criteria. They rely on a collection of intelligent components to sense their environment for operations. Those sensing components often manifest significant uncertainties due to noise from system inputs as well as disturbances from environment interferences, system faults, malicious attacks, etc. It is imperative to test and verify the goal-driven autonomous behavior considering various sources of uncertainties. This special session consists of four talks tackling the challenge of autonomous behavior at design time using appropriate architectures, supervision, and online tools. The second talk discusses how formal methods can be developed to ensure the safe application of machine learning techniques, modelling techniques, and design techniques in autonomous systems. The third talk focuses on the development of a new data analytics technique for counteracting adversarial attacks in stereo vision based autonomous driving systems. The fourth talk describes an industrial experience on preliminary evaluation of machine learning assurance technologies that have been integrated into aerospace autonomous platforms.

6D.1 EDA for Autonomous Behavior Assurance

Selma Saidi - TU Dortmund Jyotirmoy Deshmukh - USC Dirk Ziegenbein - Bosch Research Rolf Ernst - TU Braunschweig

6D.2 Know the Unknowns: Addressing Disturbances and Uncertainties in Autonomous Systems

Qi Zhu - Northwestern Univ. Wenchao Li - Boston Univ. Hyoseung Kim, Yecheng Xiang - Univ. of California, Riverside Kacper Wardega - Boston Univ. Zhilu Wang, Yixuan Wang, Hengyi Liang, Chao Huang - Northwestern Univ. Jiameng Fan - Boston Univ. Hyunjong Choi - Univ. of California, Riverside

6D.3 Counteracting Adversarial Attacks in Autonomous Driving Qi Sun, Arjun Ashok Rao - Chinese Univ. of Hong Kong Xufeng Yao, Bei Yu - CUHK Shiyan Hu - Univ. of Southampton

6D.4 Towards Assurance Evaluation of Autonomous Systems

Steven Beland, Isaac Chang, Alexander Chen, Matthew Moser, James Paunicka, Douglas Stuart, John Vian, Christina Westover, **Huafeng Yu** - *Boeing*

7A - Emerging Technologies and Innovative Applications in Synthesis *Time: 9:00am - 9:30am*

Moderator:

Christian Pilato - Polytechnic Univ. of Milan

This session is devoted to emerging technologies and innovative applications in synthesis. The first paper presents a novel retiming formulation for superconductive circuits. The second paper leverages Boolean reasoning for mining biochemical circuits from enzyme databases. The third paper introduces a neural network-based FPGA delay prediction method for high-level synthesis.

- 7A.1 Retiming for High-performance Superconductive Circuits with Register Energy Minimization Ting-Ru Lin, Massoud Pedram - Univ. of Southern California
- 7A.2 Mining Biochemical Circuits from Enzyme Databases via Boolean Reasoning Yu-Chou Lin, Jie-Hong Roland Jiang - National Taiwan Univ.
- 7A.3 Accurate Operation Delay Prediction for FPGA HLS Using Graph Neural Networks Ecenur Ustun, Chenhui Deng, Debjit Pal, Zhijing Li, Zhiru Zhang - Cornell Univ.

7B - Efficient Deep Learning Inference and Training Towards Green AI

Time: 9:00am - 9:30am

Moderator:

Yingyan Lin - Rice Univ.

Recent breakthroughs of deep learning have motivated a tremendous demand for bringing deep learning-powered intelligence into numerous resource-constrained daily life devices. However, powerful deep learning often comes with prohibitive costs, limiting their more extensive applications and raising various environmental concerns. As such, recently, there have been explosive research efforts aiming to address these limitations and concerns towards ubiquitous green Al. This session will present solutions for efficient deep learning inference and training from various aspects.

7B.1 HyperTune: Dynamic Hyperparameter Tuning for Efficient Distribution of DNN Training Over Heterogeneous Systems

Ali HeydariGorji, Siavash Rezaei - Univ. of California, Irvine Mahdi Torabzadehkashi, Hossein Bobarshad, Vladimir Alves - NGD Systems, Inc Pai Chou - Univ. of California, Irvine

7B.2 SynergicLearning: Neural Network-Based Feature Extraction for Highly-Accurate Hyperdimensional Learning Mahdi Nazemi, Amirhossein Esmaili, Arash Fayyazi, Massoud Pedram - Univ. of Southern California

7B.3 Optimizing Stochastic Computing for Low Latency Inference of Convolutional Neural Networks

Zhiyuan Chen, Yufei Ma, Zhongfeng Wang - Nanjing Univ.

7B.4 HAPI: Hardware-Aware Progressive Inference Stefanos Laskaridis, Stylianos I. Venieris, Hyeji Kim - Samsung AI Center Cambridge Nicholas D. Lane - Samsung AI Center Cambridge & Univ. of Cambridge

7C - In-Memory Computing for Hardware Acceleration *Time: 9:00am - 9:30am*

Moderator:

Jae-sun Seo - Arizona State Univ.

Crossbar arrays with resistive random access memory (ReRAM) or static random access memory (SRAM) are common technologies for enabling in-memory computing. The first paper will discuss using a ReRAM crossbar for a Natural Language Processing (NLP) model acceleration. The second paper will present a programming protocol to precisely tune the ReRAM conductance for accurate computation. The third paper will discuss how to leverage the conventional 6-transistor SRAM to implement a binary neural network with negligible accuracy degradation.

- 7C.1 ReTransformer: ReRAM-based Processing-in-Memory Architecture for Transformer Acceleration Xiaoxuan Yang, Bonan Yan, Hai Li, Yiran Chen - Duke Univ.
- 7C.2 SWIPE: Enhancing Robustness of ReRAM Crossbars for In-memory Computing Sujan K. Gonugondla, Ameya D. Patil, Naresh R. Shanbhag - Univ. of Illinois at Urbana-Champaign
- 7C.3 Energy-efficient XNOR-free In-Memory BNN Accelerator with Input Distribution Regularization Hyungjun Kim, Hyunmyung Oh, Jae-Joon Kim - Pohang Univ. of Science and Technology



Special Session 7D - Opensource Tools and Platforms for Agile Development of Specialized Architectures *Time: 9:00am - 9:30am*

Moderator:

Antonino Tumeo - Pacific Northwest National Lab

Organizer:

Antonino Tumeo - Pacific Northwest National Lab

As new technology nodes have started to progressively provide diminishing returns in terms of power consumption and performance, we have entered a new golden era for domain-specific architectures at all system scales. However, developing specialized architectures currently requires substantial efforts and large teams, for both hardware and software. Several research initiatives are developing new tools, interfaces, intellectual properties, and platforms to enable small development teams to explore and implement specialized systems with quick, modularized, and fail fast (Agile). At the same time, there is a desire to provide opensource, community driven, and interoperable systems to maximize reuse and facilitate integration. The talks of this special session discuss openly available tools and platforms that allows to quickly transition the design of specialized architectures from the high-level algorithmic descriptions to their implementation.

- 7D.1 Your Agile Open Source HW Stinks (Because It Is Not a System) Michael B. Taylor - Univ. of Washington
- 7D.2 Agile SoC Development with Open ESP
 Paolo Mantovani, Davide Giri, Giuseppe Di Guglielmo, Luca Piccolboni, Joseph Zuckerman
 Columbia Univ.
 Emilio G. Cota, Michele Petracca, Christian Pilato, Luca P. Carloni Columbia Univ.

7D.3 A Simulator and Compiler Framework for Agile Hardware-Software Co-designs Evaluation and Exploration

Tyler Sorensen - UC Santa Cruz Aninda Manocha, Esin Tureci, Marcelo Orenes Vera - Princeton Univ. Juan L. Aragón - Univ. of Murcia Margaret Martonosi - Princeton Univ.

7D.4 SODA: a New Synthesis Infrastructure for Agile Hardware Design of Machine Learning Accelerators

Marco Minutoli, Vito Giovanni Castellana, Cheng Tan, Joseph Manzano, Vinay Amatya, Antonino Tumeo - *Pacific Northwest National Lab* David Brooks, Gu-Yeon Wei - *Harvard Univ*.

8A - Cross-layer Design for Timing Resilient Embedded Systems

Time: 9:30am - 10:00am

Moderator:

Song Han - Univ. of Connecticut

For the design of many safety-critical systems, a key challenge is to meet the stringent timing requirements and ensure functional correctness with limited resources. The three papers in this session address this challenge with novel cross-layer methods, including co-designing sampling periods and poles of real-time controller to improve control performance and system schedulability for time-sensitive networking, scheduling mixed-criticality systems precisely on a varying-speed processor for guaranteeing the completion of every task, and relaxing traditional hard deadlines with weakly-hard constraints to improve system fault tolerance while ensuring schedulability and control stability.

 8A.1 Fixed-Priority Scheduling and Controller Co-Design for Time-Sensitive Networks Xiaotian Dai, Shuai Zhao - Univ. of York Yu Jiang - Tsinghua Univ. Xun Jiao - Villanova Univ. Xiaobo Sharon Hu - Univ. of Notre Dame Wanli Chang - Univ. of York
 8A.2 F2VD: Fluid Rates to Virtual Deadlines for Precise Mixed-Criticality Scheduling on a

Varying-Speed Processor
 Kecheng Yang - Texas State Univ.
 Ashikahmed Bhuiyan, Zhishan Guo - Univ. of Central Florida

8A.3 Leveraging Weakly-hard Constraints for Improving System Fault Tolerance with Functional and Timing Guarantees

Hengyi Liang, Zhilu Wang, Ruochen Jiao, Qi Zhu - Northwestern Univ.

8B - ReRAM-based Accelerators for Neural Networks *Time: 9:30am - 10:00am*

Moderator:

Marco Donato - Tufts Univ.

ReRAM hardware accelerators provide high energy efficiency for data-intensive applications such as Deep Neural Network inference. However, device non-idealities pose significant challenges to the design of reliable and scalable ReRAM-based hardware. The papers in this session offer a range of solutions from circuit-level optimizations, new processing-in-memory architectures, and HW/SW co-design.

- 8B.1 Thermal-aware Optimization Framework for ReRAM-based Deep Neural Network Acceleration Hyein Shin, Myeonggu Kang, Lee-Sup Kim - Korea Advanced Institute of Science and Technology
 8B.2 Unlocking Wordline-level Parallelism for Fast Inference on RRAM-based
- Wordline-level Parallelism for Fast Inference on RRAM-based
 DNN Accelerator
 Yeonhong Park, Seung Yul Lee, Hoon Shin, Jun Heo, Tae Jun Ham, Jae W. Lee Seoul National Univ.
- 8B.3 MobiLattice: A Depth-wise DCNN Accelerator with Hybrid Digital/Analog Nonvolatile Processing-In-Memory Block Qilin Zheng, Xingchen Li, Zongwei Wang, Yimao Cai, Guangyu Sun, Ru Huang - Peking Univ.

Quin Zneng, Xingchen Li, Zongwei Wang, Yimao Cai, Guangyu Sun, Ru Huang - *Peking Univ*. Yiran Chen, Hai Li - *Duke Univ*.

 8B.4 HitM: High-Throughput ReRAM-based PIM for Multi-Modal Neural Networks Bing Li - Capital Normal Univ.
 Ying Wang - Chinese Academy of Sciences
 Yiran Chen - Duke Univ.

8C - Safety and Security Validation Time: 9:30am - 10:00am

Moderator:

Abhijit Chatterjee - Georgia Institute of Technology

Automated validation of safety and security properties in modern processor designs is a challenging problem. The first presentation explores a unified hardware and firmware security property co-validation framework in the presence of adversarial behavior. The second presentation is on proving the safety properties of hardware and software using word-level as opposed to bit-level reasoning. The third presentation examines simulation-based functional verification, allowing the selection of inputs that permit a uniform selection of execution traces for verification coverage. The final presentation is on test generation for exposing embedded hardware Trojans in digital logic using delay-based side-channel analysis.

- *8C.1 HyperFuzzing for SoC Security Validation Sujit Kumar Muduli, Gourav Takhar, Pramod Subramanyan - Indian Institute of Technology Kanpur
- 8C.2 Word Level Property Directed Reachability Hari Govind V K - Univ. of Waterloo Grigory Fedyukovich - Florida State Univ. Arie Gurfinkel - Univ. of Waterloo
- 8C.3 On Uniformly Sampling Traces of a Transition System Supratik Chakraborty - Indian Institute of Technology Bombay Aditya A. Shrotri, Moshe Y. Vardi - Rice Univ.
- **8C.4** Test Generation using Reinforcement Learning for Delay-based Side Channel Analysis Zhixin Pan, Jennifer Sheldon, Prabhat Mishra - Univ. of Florida



Special Session 8D - Taking Open-Source EDA to the Next Level: From Research to Production IC Design *Time*: 9:30am - 10:00am

Moderator:

Andrew B. Kahng - Univ. of California, San Diego

Organizers:

Andrew Kahng - Univ. of California, San Diego Tom Spyrou - Univ. of California, Sand Diego and Precision Innovations, Inc.

Two years have passed since the launch of the DARPA Electronics Resurgence Initiative (ERI) brought renewed attention to open-source EDA and hardware development. During this past summer (2020), many ERI-supported open-source projects have made their v1.0 releases. This session examines the next stage of the "life cycle" for open-source EDA in the digital RTL-to-GDS space: moving from the research context to production IC design. Diverse speakers and perspectives collectively highlight how "it takes a village" for open-source EDA to make real-world impact.

The session presents four distinct perspectives. (1) The first talk presents the experience of a commercial design service provider in building a production SOC tapeout methodology and flow based on open-source EDA. (2) The second talk presents the experience of "internal design advisors" who have functioned as the bridge between research tool code development and usability for production IC design. (3) The third talk examines essential aspects of, and the outlook for, open design and research enablement (PDKs, libraries, IPs, incentivization) that goes beyond open-source EDA itself. (4) The fourth talk presents the experience (engagement framework, logistics, incentives, academic rewards) and perspective of students who have contributed to an open-source EDA tool and flow development project from non-U.S. locations.

- 8D.1 Building OpenLANE: A 130nm OpenROAD-based Tapeout-Proven Flow Mohamed Kassem, Tim Edwards - eFabless.com
 Mohamed Shalan - eFabless.com & American Univ. of Cairo
- 8D.2 Bridging Academic Open-Source EDA to Real-World Usability Austin Rovinski, Tutu Ajayi - Univ. of Michigan Minsoo Kim - Univ. of California, San Diego Guanru Wang, Mehdi Saligane - Univ. of Michigan
- 8D.3 The Missing Pieces of Open Design Enablement: A Recent History of Google Efforts Tim Ansell - Google Mehdi Saligane - Univ. of Michigan

8D.4 Contributions to OpenROAD from Abroad: Experiences and Learnings Mateus Fogaca, Eder Monteiro - UFRGS Marcelo Danigno - FURG Isadora Oliveira, Paulo Butzen - UFRGS & Federal Univ. of Rio Grande do Sul Ricardo Reis - UFRGS

WEDNESDAY SCHEDULE

6:30 - 7:00am

9A: Novel Frameworks for HLS and Accelerator Design and Optimization

9B: Neural Network Assisted Modeling of Analog Circuits

9C: Approximate Yet Dependable

Special Session 9D: The Future of Heterogeneous Integration and In-Memory Computing: Research Highlights of ERI Programs from US and Taiwan

7:00 - 8:00am

KEYNOTE: EDA for More-Moore and More-than-Moore Designs: Challenges and Opportunities

Yao-Wen Chang - National Taiwan Univ..

8:00 - 8:30am

10A: Advances in Boolean Reasoning, Representation and Optimization

10B: Methods and Applications of Analog Circuit Placement and Simulation

10C: EDA for Quantum Computing

Special Session 10D: Machine Learning and Hardware Security: Challenges and Opportunities

8:30 - 9:00am 11A: Modern and Domain Specific Placement

11B: Efficiency Improvement for Timing, Power Grid and Circuit Analysis

11C: EDA for Emerging Technologies based Computing Systems

Special Sessionl 11D: Robust Quantum Computers: Challenges, Solutions and Future Directions

9:00 - 9:30am

12A: Extreme Automation in Standard Cell Synthesis and ECO Optimization

12B: Deep Learning and Back-end Design

Special Session 12C: Towards Real-time Energy-efficient Mobile Robotics: From Algorithm to Hardware

Embedded Tutorial 12D: GPU Acceleration in CAD: Opportunities and Challenges

9A - Novel Frameworks for HLS and Accelerator Design and Optimization *Time: 6:30am - 7:00am*

Moderator:

Hari Cherupalli - Univ. of Minnesota

This session covers new EDA techniques for design and optimization including NoC and AxC. The first paper proposes NASCaps, a new hardware-aware neural architecture search framework that uses a multi-objective genetic algorithm to search for an optimal architecture on both traditional deep neural networks and networks with specialized capsule layers and dynamic routing. The second paper presents an early detection methodology, ReconfAST, to identify computationally similar synthesizable kernels that are used to build shared accelerators. The third paper proposes a CAD tool to improve high-level synthesis based on the Roofline model. The fourth paper presents the application of design space exploration for hardware accelerators by taking advantage of approximate modules.

9A.1 NASCaps: A Framework for Neural Architecture Search to Optimize the Accuracy and Hardware Efficiency of Convolutional Capsule Networks

Alberto Marchisio - Technische Univ. Wien Andrea Massa - Politecnico di Torino Vojtech Mrazek - Brno Univ. of Technology Beatrice Bussolino, Maurizio Martina - Politecnico di Torino Muhammad Shafique - New York Univ. Abu Dhabi

9A.2 Early-stage Automated Accelerator Identification Tool for Embedded Systems with Limited Area

Parnian Mokri, Mark Hempstead - Tufts Univ.

9A.3 A CAD-based methodology to optimize HLS code via the Roofline model

Marco Siracusa - Politecnico di Milano Marco Rabozzi - Huxelerate SRL Emanuele Del Sozzo - Politecnico di Milano Lorenzo Di Tucci - Huxelerate SRL Samuel Williams - Lawrence Berkeley National Lab Marco D. Santambrogio - Politecnico di Milano

9A.4 AxHLS: Design Space Exploration and High-Level Synthesis of Approximate Accelerators using Approximate Functional Units and Analytical Models Jorge Castro-Godínez - Karlsruhe Institute of Technology & Instituto Tecnológico de Costa Rica Julian Mateus-Vargas - Instituto Tecnológico de Costa Rica Muhammad Shafique - New York Univ. Abu Dhabi & New York Univ. Abu Dhabi

Joerg Henkel - Karlsruhe Institute of Technology

9B - Neural Network Assisted Modeling of Analog Circuits

Time: 6:30am - 7:00am

Moderator:

Karthik Aadithya - Sandia National Laboratories

The session presents three papers on novel applications of neural networks to analog circuit modeling. The first paper addresses the early performance assertion of analog circuits using a convolutional neural network-based scheme. The second paper applies transfer learning and Bayesian optimization to enable efficient sampling for performance modeling of analog-mixed-signal circuits. The third paper adopts a graph neural network formulation to identify symmetry constraints for the layout of analog circuits.

9B.1 CEPA: CNN-based Early Performance Assertion Scheme for Analog and Mixed-Signal Circuit Simulation Qiaochu Zhang, Shiyu Su, Juzheng Liu, Mike Shuo-Wei Chen - Univ. of Southern California

9B.2 Transfer Learning with Bayesian Optimization-Aided Sampling for Efficient AMS Circuit Modeling Juzheng Liu, Mohsen Hassanpourghadi, Qiaochu Zhang, Shiyu Su, Mike Shuo-Wei Chen - Univ. of Southern California

9B.3 A general approach for identifying hierarchical symmetry constraints for analog circuit layout
 Kishor Kunal, Jitesh Poojary, Tonmoy Dhar, Meghna Madhusudan, Ramesh Harjani - Univ. of Minnesota

Sachin S. Sapatnekar - Univ. of Minnesota, Twin Cities

9C - Approximate Yet Dependable Time: 6:30am - 7:00am

Moderator:

Jie Gu - Northwestern Univ.

This session presents a collection of works focusing on various aspects of approximate and stochastic computing, ranging from the design of approximate hardware to mathematical foundations to number representations and error modeling. The first paper extends the state-of-the-art approximate functional unit design to reconfigurable modules. The second paper combines the logic function analysis with gate-level circuit optimization. The third paper leverages a new encoding technique to create low cost and high-performance approximate multipliers. The final paper presents practical models for designers to perform high precision accuracy analysis during the design cycle of stochastic logic.

*9C.1 Optimally Approximated and Unbiased Floating-Point Multiplier with Runtime Configurability

Chuangtao Chen, Sen Yang - Zhejiang Univ. Weikang Qian - Shanghai Jiao Tong Univ. Mohsen Imani - Univ. of California, Irvine Xunzhao Yin, Cheng Zhuo - Zhejiang Univ.

- 9C.2 Exploring Target Function Approximation for Stochastic Circuit Minimization Chen Wang, Weihua Xiao - Shanghai Jiao Tong Univ. John P. Hayes - Univ. of Michigan Weikang Qian - Shanghai Jiao Tong Univ.
- 9C.3 Hybrid Binary-Unary Truncated Multiplication for DSP Applications on FPGAs S. Rasoul Faraji, Kia Bazargan - Univ. of Minnesota, Twin Cities
- 9C.4 Bayesian Accuracy Analysis of Stochastic Circuits Timothy J. Baker, John P. Hayes - Univ. of Michigan

WEDNESDAY, NOVEMBER 4

Special Session 9D - The Future of Heterogeneous Integration and In-Memory Computing: Research Highlights of ERI Programs from US and Taiwan *Time: 6:30am - 7:00am*

Moderator:

Tsung-Yi Ho - National Tsing Hua Univ.

Organizer:

Tsung-Yi Ho - National Tsing Hua Univ.

This special session is targeted towards Univ. researchers/professors, Ph.D. students, industry professionals, and computing system designers. This session will attract newcomers who want to learn about technologies and EDA challenges associated with heterogeneous integration and in-memory computing, as well as experienced researchers looking for exciting new directions in advanced packaging, monolithic 3D ICs, and memory-centric AI edge applications. This special session will also highlight cutting-edge research and future roadmap for both Electronics Resurgence Initiative (ERI) programs from US and Taiwan.

9D.1 Intelligent Design Automation for 2.5/3D Heterogeneous SoC Integration Iris Hui-Ru Jiang, Yao-Wen Chang, Jiun-Lang Huang, Chung-Ping Chen - National Taiwan Univ.

9D.2 RTL-to-GDS Design Tools for Monolithic 3D ICs

Jinwoo Kim, Gauthaman Murali, Pruek Vanna-iampikul, Edward Lee, Daehyun Kim - *Georgia* Institute of Technology Arjun Chaudhuri, Sanmitra Banerjee, Krishnendu Chakrabarty - *Duke Univ*. Saibal Mukhopadhyay, **Sung-Kyu Lim** - *Georgia Institute of Technology*

9D.3 On EDA Solutions for Reconfigurable Memory-Centric AI Edge Applications Hung-Ming Chen, Chia-Lin Hu, Kang-Yu Chang - National Chiao Tung Univ. Alexandra Küster - National Chiao Tung Univ. & RWTH Aachen Univ. Yu-Hsien Lin, Po-Shen Kuo, Wei-Tung Chao, Bo-Cheng Lai, Chien-Nan Liu, Shyh-Jye Jou -National Chiao Tung Univ.

9D.4 Fundamental Limits on the Precision of In-memory Architectures

Sujan K. Gonugondla, Charbel Sakr, Hassan R. Dbouk, Naresh R. Shanbhag - Univ. of Illinois at Urbana-Champaign



EDA for More-Moore and More-than-Moore Designs: Challenges and Opportunities Time: 7:00am - 8:00am

Speaker:

Yao-Wen Chang - National Taiwan Univ.

As the process technology approaches the physics limit, the semiconductor industry faces severe manufacturing and design challenges. Though at a slower pace than ever before, on the one hand, Moore's Law continues to push the limits of process lithography into the deep nanometer regime for better area, performance, and power. On the other hand, More-than-Moore technologies add diverse devices and adopt 2.5D/3D heterogeneous integration to achieve better system-level power-performance-cost tradeoffs and higher design functionality. In this talk, we investigate most expected More-Moore patterning, interconnect, and transistor technologies and More-than-Moore system-level heterogeneous integration, address their implications and challenges for advanced circuit and system implementations, highlight current EDA solutions, and suggest future research opportunities for these emerging challenges from the perspectives of technology, heterogeneity, scalability, and multi-objective requirements.

Biography: Yao-Wen Chang received the B.S. degree from National Taiwan Univ. (NTU) in 1988, and the M.S. and Ph.D. degrees from the Univ. of Texas at Austin in 1993 and 1996, respectively, all in computer science. He is currently Distinguished Professor and the Dean of the College of Electrical Engineering and Computer Science, NTU. His current research interests lie in electronic design automation (EDA), with emphasis on physical design and manufacturability. He has coauthored one textbook on EDA and another book on routing and over 320 ACM/IEEE conference/ journal papers, including highly cited papers on floorplanning, placement, routing, manufacturability, and FPGA design. His NTUplace3 placer was transferred as the popular Custom Digital Placer of SpringSoft, acquired by the #1 EDA vendor, Synopsys, for US \$400 million in 2012. His NTUplace4 is a 3-time champion from the DAC'12, ICCAD'13, and ISPD'15 placement contests, then the core engine of the MaxPlace placer, a leading placer of the Maxeda Technology co-founded by Dr. Chang in 2015. Dr. Chang received four awards at the 50th DAC in 2013 for the 1st Most Papers in DAC's Fifth Decade (34 papers; #1 worldwide), etc. He is a winner of 21 top-3 place awards at ACM/IEEE EDA contests, 10 best paper awards (including DAC'17), and 23 best paper nominations from DAC (5 times), ICCAD (5 times), etc. He has received many research/teaching awards, such as the Distinguished Research Award from the Ministry of Science and Technology of Taiwan (three times, the limit), the IBM Faculty Awards (three times), and the MXIC Chair Professorship and two distinguished (highest honor) and nine excellent teaching awards from NTU.

Dr. Chang is an IEEE Fellow and currently the President of the IEEE CEDA. He has served on the editorial boards of IEEE TCAD, IEEE TVLSI, IEEE D&T, etc. He has also served as program/general chairs of ICCAD, program/general/steering committee chairs of ISPD, and program chairs of ASP-DAC and FPT. He has also served as an independent board director of Genesys Logic, a technical consultant of Faraday, MediaTek, and RealTek, and chair of the EDA Consortium of the MOE, Taiwan.

10A - Advances in Boolean Reasoning, Representation and Optimization

Time: 8:00am - 8:30am

Moderator:

Heinz Riener - École Polytechnique Fédérale de Lausanne

This session introduces the latest progress in Boolean methods, encompassing sampling, optimization, representation and mapping problems. The first paper describes a method to construct uniform and compact sampling circuits for a given Boolean space. The second paper proposes a multi-stage, multi-armed bandit framework for Boolean optimization. The third paper presents minimization strategies for Bi-Kronecker Functional Decision Diagrams. The last paper extends the concept of priority cuts to map dual-output LUTs.

- **10A.1** Symbolic Uniform Sampling with XOR Circuits Yen-Ting Lin, Jie-Hong Roland Jiang - National Taiwan Univ. Victor Kravets - IBM Research
- **10A.2 FlowTune: Practical Multi-armed Bandits in Boolean Optimization Cunxi Yu** - Univ. of Utah
- 10A.3 Dynamic Minimization of Bi-Kronecker Functional Decision Diagrams Xuanxiang Huang - Jinan Univ. & ANITI, Univ. of Toulouse Haipeng Che, Liangda Fang - Jinan Univ. & Guilin Univ. of Electronic Technology Qingliang Chen, Quanlong Guan, Yuhui Deng - Jinan Univ. Kaile Su - Griffith Univ.
- 10A.4 Dual-Output LUT Merging during FPGA Technology Mapping Feng Wang, Liren Zhu, Jiaxi Zhang - Peking Univ. Lei Li, Yang Zhang - Huawei Technologies Co., Ltd. Guojie Luo - Peking Univ.

10B - Methods and Applications of Analog Circuit Placement and Simulation

Time: 8:00am - 8:30am

Moderator:

Eric Keiter - Sandia National Laboratories

The session presents four papers on the methods and applications of analog circuit placement and simulation. The first paper addresses an analytic placement utilizing signal flow information to improve the circuit performance. The second paper targets the placement of an adiabatic quantumflux-parametron that claims to enjoy very low energy consumption and high-speed execution. The third paper adopts a graph neural network model to guide the simulated annealing placement process. The fourth paper presents a novel approach for simulating circuits with in-memory computing modules.

10B.1 Effective Analog/Mixed-Signal Circuit Placement Considering System Signal Flow Keren Zhu, Hao Chen, Mingjie Liu, Xiyuan Tang, Nan Sun, David Z. Pan - Univ. of Texas at Austin

10B.2 ASAP: An Analytical Strategy for AQFP Placement

Yi-Chen Chang - National Tsing Hua Univ. Hongjia Li - Northeastern Univ. Olivia Chen - Yokohama National Univ. Yanzhi Wang - Northeastern Univ. Nobuyuki Yoshikawa - Yokohama National Univ. Tsung-Yi Ho - National Tsing Hua Univ.

10B.3 A Customized Graph Neural Network Model for Guiding Analog IC Placement

Yaguang Li, Yishuang Lin - Texas A&M Univ. Meghna Madhusudan, Arvind Sharma - Univ. of Minnesota Wenbin Xu - Texas A&M Univ. Sachin S. Sapatnekar, Ramesh Harjani - Univ. of Minnesota Jiang Hu - Texas A&M Univ.

10B.4 CCCS: Customized SPICE-level Crossbar-array Circuit Simulator for In-Memory Computing

Fan Zhang - Arizona State Univ. Miao Hu - Binghamton Univ.

10C - EDA for Quantum Computing Time: 8:00am - 8:30am

Moderator:

Daniel Große - Johannes Kepler Univ. Linz

Quantum computing is gaining interest and EDA needs to be ready for that. This session proposes recent advancements in this regard. The first two papers cover an important step in the compilation process of quantum algorithms, which aims to map an original quantum circuit onto a real architecture. Afterwards, a classification scheme for IBM quantum computers is proposed and, finally, how to efficiently simulate decoherence errors in quantum circuits is discussed.

- 10C.1 Optimal Layout Synthesis for Quantum Computing Bochen Tan, Jason Cong - Univ. of California, Los Angeles
- **10C.2** A Monte Carlo Tree Search Framework for Quantum Circuit Transformation Xiangzhen Zhou, Yuan Feng, Sanjiang Li - Univ. of Technology Sydney
- *10C.3 DISQ: A Novel Quantum Output State Classification Method on IBM Quantum Computers using OpenPulse Tirthak Patel, Devesh Tiwari - Northeastern Univ.
- 10C.4 Considering Decoherence Errors in the Simulation of Quantum Circuits Using Decision Diagrams

Thomas Grurl, Jürgen Fuß - Univ. of Applied Sciences Upper Austria Robert Wille - Johannes Kepler Univ. Linz & Software Competence Center Hagenberg GmbH



Special Session 10D - Machine Learning and Hardware Security: Challenges and Opportunities *Time: 8:00am - 8:30am*

Moderator:

Shivam Bhasin - Nanyang Technological Univ.

Organizers:

Shivam Bhasin - Nanyang Technical Univ. Francesco Regazzoni - Univ. of Amstedam and ALaRI - USI

Machine learning techniques have significantly changed our live. They helped improving several of our everyday applications, but they also have been demonstrated to be an extremely helpful tool for more advanced and complex applications. However, the implications on hardware security problems of a massive diffusion of machine learning techniques is still to be completely understood. This special session consists of 4 papers and addresses hardware security issues related with the use of machine learning and threats that classical attacks to hardware can cause to machine learning implementations. The topic is timely, and of interest of the attendees of ICCAD. Machine learning implementations are pervading every aspect of our lives, and their diffusion in IoT devices and Cyber-physical systems expose them to classical hardware security threats such as side channel attacks. Recent results demonstrated the feasibility of the approach. For instance, a recent attack demonstrated that a generic and practical reverse engineering of neural networks on embedded microcontrollers is indeed possible and these threat needs to be addressed in a proper way with dedicated countermeasures. On the other side, machine learning can be used also as a powerful tool to improve the resistance of hardware security or to improve the effectiveness of the attacks. It is thus of crucial importance that designers of future IoT devices and Cyber-physical systems, are aware of the most important security challenges caused by the massive use of machine learning techniques, which needs to be addressed a correct and effective way.

10D.1 Physically Unclonable Functions Extracted from Embedded Neural Networks

Ihab Alshaer - Univ. Grenoble Alpes & TIMA Lab, CNRS/Grenoble INP/UJF Amir Ali Pour - Grenoble INP David Hely - Grenoble-INP Vincent Beroulle - Grenoble INP Elena Ioana Vatajelu - Univ. Grenoble Alps **Giorgio Di Natale** - univ-grenoble-alpes

10D.2 Breaking Side-Channel Countermeasures Through Deep Learning

Furkan Aydin, Priyank Kashyap, Seetal Potluri, Paul Franzon, **Aydin Aysu** - North Carolina State Univ.

10D.3 Model Extraction Attack on Practical BNN Hardware using EM Side-Channel Information

Ville Yli-Mayry, Akira Ito, Rei Ueno - Tohoku Univ. Dirmanto Jap - Temasek Laboratories, NTU Shivam Bhasin - Temasek Laboratories, NTU Singapore Naofumi Homma - Tohoku Univ.

10D.4 Protections Against Physical Attacks on Machine Learning Hardware

Ilia Polian - Univ. of Stuttgart Francesco Regazzoni - Univ. of Amsterdam and ALaRI - USI

11A - Modern and Domain Specific Placement Time: 8:30am - 9:00am

Moderator:

Laleh Behjat - Univ. of Calgary

The placement process is an essential step in the physical design flow as the circuit performance, area and power consumption are highly dependent on the quality of the solution provided by the placement process. With shrinking size of transistors in modern technology processes, the placement problem has become ever more challenging due to a variety of intricate constraints and different design paradigms, such as asynchronous circuits. To address the arisen challenges, innovative approaches incorporating Machine Learning (ML)-based techniques and state-of-the-art analytic placement frameworks seem to be inevitable.

This session consists of 4 papers addressing these challenges. The first paper proposes a highperformance engine fully customized to address challenges arisen from the physical mapping of neural network workloads onto the largest commercial deep learning accelerator. The second paper presents a multi-electrostatic-based placement framework accounting for fence regions. The third paper proposes a deep reinforcement learning-based framework for VLSI placement parameter optimization, and finally, the fourth paper develops a placement framework for asynchronous circuits.

- 11A.1 CU.POKer: Placing DNNs on Wafer-Scale Al Accelerator with Optimal Kernel Sizing Bentian Jiang, Jingsong Chen, Jinwei Liu, Lixin Liu, Fangzhou Wang, Xiaopeng Zhang, Evangeline F.Y. Young - Chinese Univ. of Hong Kong
- 11A.2 DREAMPlace 3.0: Multi-Electrostatics Based Robust VLSI Placement with Region Constraints

Jiaqi Gu, Zixuan Jiang - Univ. of Texas at Austin Yibo Lin - Peking Univ. David Z. Pan - Univ. of Texas at Austin

11A.3 VLSI Placement Parameter Optimization using Deep Reinforcement Learning Anthony D. Agnesina, Kyungwook Chang, Sung Kyu Lim - Georgia Institute of Technology

11A.4 Dali: A Gridded Cell Placement Flow Yihang Yang - Yale Univ. Jiayuan He - Univ. of Texas at Austin Rajit Manohar - Yale Univ.

11B - Efficiency Improvement for Timing, Power Grid and Circuit Analysis

Time: 8:30am - 9:00am

Moderator:

Kerim Kalfala - IBM Corp.

The session explores different approaches to improving timing, power grid design, and circuit analysis. The first paper applies dynamic programming to optimize the power distribution network to meet timing. The second paper shows how timing analysis can be accelerated by utilizing a GPU architecture. The third paper presents a new graph spectral sparsification technique to build a better conditioner for an iterative circuit solver. The last paper presents a novel stack about a design method by incorporating linear or dynamic programming methods.

11B.1 Power Distribution Network Generation for Optimizing IR-Drop Aware Timing

Wen-Hsiang Chang - National Chiao Tung Univ. & Realtek Semiconductor Corp. Li-Yi Lin - Realtek Semiconductor Corp. **Yu-Guang Chen** - National Central Univ. Mango C.-T. Chao - National Chiao Tung Univ.

11B.2 GPU-Accelerated Static Timing Analysis

Zizheng Guo - Peking Univ. Tsung-Wei Huang - Univ. of Utah Yibo Lin - Peking Univ.

11B.3 SF-GRASS: Solver-Free Graph Spectral Sparsification

Ying Zhang - Stevens Institute of Technology Zhiqiang Zhao - Michigan Technological Univ. Zhuo Feng - Stevens Institute of Technology

11B.4 Meshed Stack Via Design Considering Complicated Design Rules with Automatic Constraint Generation

Kai-Chuan Yang, Tao-Chun Yu, Shao-Yun Fang - National Taiwan Univ. of Science and Technology

Teng-Yuan Cheng, Yang-Chun Liu, Cindy Chin-Fang Shen - Synopsys Taiwan Co., Ltd.

11C - EDA for Emerging Technologies based Computing Systems

Time: 8:30am - 9:00am

Moderator:

Chenchen Liu - Univ. of Maryland, Baltimore County

Emerging technologies have dramatically revolutionized the development of computing systems, while the progress of design automation of these new systems falls behind. This session proposes the latest research outcomes in this field. The first two papers discuss the resistance mapping solutions for resistive memory processing designs. Then a framework is proposed to counter the variation and thermal effects for optical neural networks. Finally, the risk of malicious/unpredictable changes in error rates of NISQ computers is explored and addressed.

11C.1 CONTRA: Area-Constrained Technology Mapping Framework For Memristive Memory Processing Unit

Debjyoti Bhattacharjee, Anupam Chattopadhyay - Nanyang Technological Univ. Srijit Dutta - SAMSUNG Ronny Ronen, Shahar Kyatinsky - Technion - Israel Institute of Technology

11C.2 DP-MAP: Towards Resistive Dot-Product Engines with Improved Precision

Necati Uysal, Baogang Zhang - Univ. of Central Florida Sumit Kumar Jha - Univ. of Texas at San Antonio Rickard Ewetz - Univ. of Central Florida

 11C.3 Countering Variations and Thermal Effects for Accurate Optical Neural Networks Ying Zhu, Grace Li Zhang, Bing Li - Tech. Univ. of Munich Xunzhao Yin, Cheng Zhuo - Zhejiang Univ. Huaxi Gu - Xidian Univ. Tsung-Yi Ho - National Tsing Hua Univ. Ulf Schlichtmann - Tech. Univ. of Munich

11C.4 A Lightweight Approach to Detect Malicious/Unexpected Changes in the Error Rates of NISQ Computers

Nikita Acharya, Samah Saeed - City Univ. of New York

Special Session 11D - Robust Quantum Computers: Challenges, Solutions and Future Directions

Time: 8:30am - 9:00am

Moderator:

Moinuddin Qureshi - Georgia Tech

Organizers:

Swaroop Ghosh - Pennsylvania State Univ. Anupam Chattopadhyay - Nanyang Technological Univ. Robert Wille - Johannes Kepler Univ. Linz

This special session will provide an in-depth treatment of the resilience of NISQ era quantum computers. The first talk will describe the holistic design flow of a quantum accelerator. The second talk will provide an overview of the Quantum Scientific Computing Open User Testbed (QSCOUT) developed at Sandia National Labs for trapped-ion qubits. It will also describe the implementation of the multi-channel dual tone modulation and control system in a Radio-Frequency System on a Chip (RFSoC) device. The third talk will cover compilation flows for quantum algorithms with focus on the correctness analysis. The fourth talk will introduce the use of Quantum Random Access Coding (QRAC) to map discrete features of a classifier efficiently into limited number of qubits for robust Variational Quantum Circuit (VQC) to speed up the training. The final talk will present compilation techniques for quantum approximate optimization algorithm to improve error resiliency.

- 11D.1 Quantum Computing How to develop a Quantum Accelerator Koen Bertels - Univ. of Porto & Univ. do Porto
- 11D.2 Classical and Quantum Control of a Trapped Ion Quantum Computing Testbed System Daniel Lobser, Matthew Blain, Raymond Haltli, Craig W. Hogle, Andrew J. Landahl, Benjamin C. A. Morrison, Melissa Revelle, Kenneth M. Rudinger, Antonio Russo, Brandon Ruzic, Daniel Stick, Jay Van Der Wall, Christopher G. Yale - Sandia National Labs Susan Clark - Sandia National Laboratories

11D.3 JKQ: JKU Tools for Quantum Computing Robert Wille - Johannes Kepler Univ. Linz & Software Competence Center Hagenberg GmbH (SCCH) Stefan Hillmich, Lukas Burgholzer - Johannes Kepler Univ. Linz

- 11D.4 Efficient Discrete Feature Encoding for Variational Quantum Classifier Rudy Raymond - IBM Quantum, IBM Research Hiroshi Yano, Yudai Suzuki, Naoki Yamamoto - Keio Univ.
- 11D.5 Noise Resilient Compilation Policies for Quantum Approximate Optimization Algorithm Mahabubul Alam, Abdullah-Ash Saki, Junde Li - Penn State Anupam Chattopadhyay - Nanyang Technological Univ. Swaroop Ghosh - Pennsylvania State Univ.

12A - Extreme Automation in Standard Cell Synthesis and ECO Optimization

Time: 9:00am - 9:30am

Moderator:

Wuxi Li - Xilinx Inc.

This session consists of four talks, covering the emerging challenges in advanced technology nodes: The first talk proposes a machine learning (ML) model for dynamic IR-drop prediction and guides the spreading of high current-demand cells at the ECO stage. The second talk focuses on the place-and-route problem for the synthesis of multi-bit flip-flop cells with an A*-based multi-row transistor placement and a MAX-SAT based detailed router. The third talk formulates the complimentary-FET cell synthesis into a satisfiability modulo theories (SMT) problem with a dynamic complementary pin allocation scheme for routability and pin access optimization. The fourth talk integrates convolutional neural network (CNN) models into the cell layout search algorithm for routability and timing optimization by pruning the search space.

12A.1 Dynamic IR-Drop ECO Optimization by Cell Movement with Current Waveform Staggering and Machine Learning Guidance

Xuan-Xue Huang, Hsien-Chia Chen - National Taiwan Univ. Sheng-Wei Wang - National Chiao Tung Univ. Iris Hui-Ru Jiang - National Taiwan Univ. Yih-Chih Chou, Cheng-Hong Tsai - Global Unichip Corp.

12A.2 MCell: Multi-Row Cell Layout Synthesis with Resource Constrained MAX-SAT Based Detailed Routing

Yih-Lang Li, **Shih-Ting Lin** - National Chiao Tung Univ. Shinichi Nishizawa - Fukuoka Univ. Hidetoshi Onodera - Kyoto Univ.

12A.3 A Routability-Driven Complimentary-FET (CFET) Standard Cell Synthesis Framework using SMT

Chung-Kuan Cheng, **Chia-Tung Ho**, Daeyeal Lee, Dongwon Park - Univ. of California, San Diego

12A.4 iTPlace: Machine Learning-Based Delay-Aware Transistor Placement for Standard Cell Synthesis

Tai-Cheng Lee, Cheng-Yen Yang, Yih-Lang Li - National Chiao Tung Univ.

12B - Deep Learning and Back-end Design Time: 9:00am - 9:30am

Moderator:

Mandy Pant - Intel Corp.

Deep learning opens the door to new approaches for many back-end design problems ranging from cell characterization, power grid design, timing and power optimization. The first paper applies neural networks for electromigration induced IR drop prediction and localized IR drop optimization. The second paper uses graph neural networks for signoff power optimization. The third paper seeks to apply machine learning methods for the design-technology co-optimization and the last paper proposes a learning-based crosstalk noise prediction to guide physical channel routing.

*12B.1 GridNet: Fast Data-Driven EM-Induced IR Drop Prediction and Localized Fixing for On-Chip Power Grid Networks

Han Zhou, Wentian Jin, Sheldon Tan - Univ. of California, Riverside

12B.2 A Fast Learning-Driven Signoff Power Optimization Framework Yi-Chen Lu - Georgia Institute of Technology Siddhartha Nath - Synopsys, Inc. Sai Surya Kiran Pentapati, Sung Kyu Lim - Georgia Institute of Technology

12B.3 Cell Library Characterization using Machine Learning for Design Technology Co-Optimization

Florian Klemme - Karlsruhe Institute of Technology Yogesh Chauhan - Indian Institute of Technology Kanpur Joerg Henkel - Karlsruhe Institute of Technology Hussam Amrouch - Univ. of Stuttgart & Karlsruhe Institute of Technology

12B.4 Routing-Free Crosstalk Prediction

Rongjian Liang - Texas A&M Univ. Zhiyao Xie - Duke Univ. Jinwook Jung - IBM T.J. Watson Research Center Vishnavi Chauha - Texas A&M Univ. Yiran Chen - Duke Univ. Jiang Hu - Texas A&M Univ. Hua Xiang - IBM Research Gi-Joon Nam - IBM T.J. Watson Research Center

Special Session 12C - Towards Real-time Energyefficient Mobile Robotics: From Algorithm to Hardware *Time: 9:00am - 9:30am*

Moderator:

Jiang Hu - Texas A&M Univ.

Organizer:

Bo Yuan - Rutgers Univ.

Background— A Robot is a very complex information processing system. A robot needs inception capability to sense, cognition capability to understand, and decision capability to act. From the perspective of computing, such an entire sense-understand-act pipeline is involved with various computation-intensive algorithms in many fields, including but not limited to machine learning, computer vision, control, signal processing etc.

Motivation— In the emerging cyber-physical system (CPS) era, a rapidly growing field in robotics, namely mobile robotics, has received a lot of attention because of its very widespread practical applications, such as search-and-rescue, underwater exploration, and autonomous delivery. In the scenario of mobile robotics, computational resource and energy budget are typically restricted, while the need for real-time and low-power solutions become more demanding, thereby bringing severe challenges but also exciting opportunities for the VLSI and computing community.

Although the study in efficient computing for robotics is still in its infancy, recently researchers in both academia and industry have made significant progress in addressing the above challenges. These research efforts that would be presented in this special session, range from algorithm to circuit to accelerator architecture to near-sensor computing, and they will lead to promising cross-layer solutions towards real-time energy-efficient mobile robotics.

12C.1 Efficient Computing for Low-Energy Robotics Vivienne Sze - MIT

- 12C.2 Hardware Acceleration of Robot Scene Perception Algorithms Yanqi Liu, Can Eren Durman - Brown Univ. Giuseppe Calderoni - Politecnico di Torino R. Iris Bahar - Brown Univ.
- 12C.3 DaDu Series- Fast and Efficient Robot Accelerators Yinhe Han, Yuxin Yang, Xiaoming Chen, Shiqi Lian - Center for Intelligent Computing Systems, Institute of Computing Technology, Chinese Academy of Science

12C.4 TACOS: Tactile Core with Optical Strain Sensor for Robotic Smart Skin Zheyu Liu, Jingyi Zhou, Huichan Zhao, Qi Wei, **Fei Qiao**, Xinjun Liu, Huazhong Yang - Tsinghua Univ.

Embedded Tutorial 12D - GPU Acceleration in CAD: Opportunities and Challenges

Time: 9:00am - 9:30am

Moderator:

Yibo Lin - Peking Univ.

Organizers:

Yibo Lin - Peking Univ. Tsung-Wei Huang - Univ. of Utah

The semiconductor industry never stops seeking to reduce the design time and effort in modern integrated circuit (IC) implementation that incorporates billions of transistors. To allow more efficient design space exploration and optimization, the core CAD algorithms must incorporate new parallel paradigms. Meanwhile, GPU has become more and more powerful with new architectures like Volta and Turing, new features like NVLink and tensor cores, and new programming models like CUDA graphs. It is reported that both the number of floating point operations per second (FLOPS) and the peak memory bandwidth have been growing exponentially in the past 10 years. These advances bring new opportunities for accelerating the long and complicated CAD flow. This session highlights the new CAD frameworks, in both front-end and back-end stages, for accelerating modern VLSI design flows with hybrid CPU-GPU platforms.

- 12D.1 Opportunities for RTL and Gate Level Simulation using GPUs Yanqing Zhang, Haoxing Ren, Brucek Khailany - NVIDIA Corp.
- 12D.2 Empyrean ALPS-GT: GPU-accelerated Analog Circuit Simulation Chen Zhao, Zhenya Zhou, Dake Wu - Empyrean Software
- 12D.3 GPU Acceleration in VLSI Back-end Design: Overview and Case Studies Yibo Lin - Peking Univ.
- 12D.4 A General-purpose Parallel and Heterogeneous Task Programming System for VLSI CAD Tsung-Wei Huang - Univ. of Utah

THURSDAY SCHEDULE

| 8:00am - 5:00pm Top Picks in Hardware and Embedded Security |
|---|
| 8:00am - 12:00pm Designing Quantized IP Models with QKeras and hls4ml |
| 8:00am - 3:30pm 2020 ACM/IEEE International Workshop on System-Level Interconnect Problems and Pathfinding (SLIP^2) |
| 8:15am - 4:30pm Workshop on Hardware and Algorithms for Learning On-a-chip (HALO) 2020 |
| 8:00am - 12:00pm (Section 1) 2nd Workshop on Accelerator Computer Aided Design (ACCAD) 2020 |
| 9:00am - 1:00pm ······ Workshop on Open-Source EDA Technology |

FRIDAY SCHEDULE

8:00am - 12:00pm (Section 2) 2nd Workshop on Accelerator Computer Aided Design (ACCAD) 2020



Workshop - Top Picks in Hardware and Embedded Security

Time: 8:00am - 5:00pm

Organizers:

Ramesh Karri - New York Univ. Gang Qu - Univ. of Maryland -- College Park Ahmad-Reza Sadeghi - TU Darmstadt Jeyavijayan Rajendran - Texas A&M Univ.

The top picks will be selected from conference and journal papers that have appeared in leading hardware security conferences including but not limited to DAC, DATE, ICCAD, HOST, VLSI Design, CHES, ETS, VTS, ITC, IEEE S&P, Euro S&P, Usenix Security, ASIA CCS, NDSS, ISCA, HASP, MICRO, ASPLOS, HPCA, ACSAC and ACM CCS. The top picks will appear in an IEEE Design and Test (if approved) special section on "Top Picks in Hardware and Embedded Security". https://na.eventscloud.com/website/15990/?

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Srini Devadas - MIT Jeyavijayan Rajendran - Texas A&M Univ.

Workshop - Designing Quantized IP Models with QKeras and hls4ml

Time: 8:00am - 12:00pm

Organizer:

Claudionor Coelho - Palo Alto Networks, Inc.

In this hands-on workshop, we will teach the basics of quantization using QKeras and show how to create a quanized model using QKeras, and how to generate ML/DL IPs using hls4ml.

We introduce the QKeras library, an extension of the Keras library allowing for the creation of heterogeneous quantized versions of deep neural network models, through drop-in replacement of Keras layers. These are trained quantization-aware, where the user can trade-off model area or

energy consumption by accuracy. We demonstrate how the reduction of numerical precision, through quantization-aware training, significantly

reduces resource consumption while retaining high accuracy when implemented on FPGA hardware.

hls4ml library is a popular library for synthesizing ML models, supporting QKeras. It generates models based in HLS, targeted at FPGA synthesis flow.

This workshop complements the paper submission to ICCAD, giving participants hands-on experience on quantization and synthesis of ML models from industry experts in this area from Google and CERN.

Speakers:

Claudionor Coelho - Palo Alto Networks, Inc. Sioni Summers - CERN Vladimir Loncar - CERN Jennifer Ngadiuba - CERN Thea Aarrestad - CERN

2020 ACM/IEEE International Workshop on System-Level Interconnect Problems and Pathfinding (SLIP^2) *Time: 8:00am - 3:30pm*

The 2020 ACM/IEEE International Workshop on System-Level Interconnect Problems and Pathfinding (SLIP^2) is the 22nd, rebooted edition of the System-Level Interconnect Prediction (SLIP) Workshop. SLIP^2 is co-located with ICCAD 2020. It will bring together researchers and practitioners who have a shared interest in the challenges and future of system-level interconnect, and come from wide-ranging backgrounds that span system, application, design and technology. The technical goal of the workshop is to (1) identify fundamental problems, and (2) foster new pathfinding of design, analysis, and optimization of interconnect and communication fabrics in electronic systems. Additionally, a more interactive, workshop-like tone and format - recalling earlier editions of the SLIP workshop - is a goal for SLIP^2 this year. Original submissions in the form of regular technical papers, invited sessions (tutorials, panels, special-topic sessions), workshop discussion topics, and posters are welcome. Accepted technical papers will be published in the ACM and IEEE digital libraries.

Since SLIP^2 is virtual, registration is free and included with the ICCAD registration.

For complete details visit website: http://sliponline.org/



Workshop - Workshop on Hardware and Algorithms for Learning On-a-chip (HALO) 2020 *Time: 8:15am - 4:30pm*

Organizers:

Qinru Qiu - Syracuse Univ. Yingyan Lin - Rice Univ. Chenchen Liu - Univ. of Maryland

In recent years, machine/deep learning algorithms has unprecedentedly improved the accuracies in practical recognition and classification tasks, some even surpassing human-level accuracy. While significant progresses have been made on accelerating the models for real-time inference on edge and mobile devices, the training of the models largely remains offline on server side. State-of-the-art learning algorithms for deep neural networks (DNN) imposes significant challenges for hardware implementations in terms of computation, memory, and communication. This is especially true for edge devices and portable hardware applications, such as smartphones, machine translation devices, and smart wearable devices, where severe constraints exist in performance, power, and area.

There is a timely need to map the latest complex learning algorithms to custom hardware, in order to achieve orders of magnitude improvement in performance, energy efficiency and compactness. Exemplary efforts from industry and academia include many application-specific hardware designs (e.g., xPU, FPGA, ASIC, etc.). Recent progress in computational neurosciences and nanoelectronic technology, such as emerging memory devices, will further help shed light on future hardware-software platforms for learning on-a-chip. At the same time new learning algorithms need to be developed to fully explore the potential of the hardware architecture.

The overarching goal of this workshop is to explore the potential of on-chip machine learning, to reveal emerging algorithms and design needs, and to promote novel applications for learning. It aims to establish a forum to discuss the current practices, as well as future research needs in the aforementioned fields. For complete details visit website: https://iccad-halo.github.io/?

Speakers:

Mike Davies - Intel Corp. Nathan McDonald - Air Force Research Lab Hai (Helen) Li - Duke Univ. Travis Dewolf - Applied Brian Research Deming Chen - Univ. of Illinois at Urbana-Champaign Yiyu Shi - Univ. of Notre Dame Yanzhi Wang - Northeastern Univ. Eriko Nurvitadhi - Intel Corp. Priya Panda - Yale Univ.

THURSDAY, NOVEMBER 5 FRIDAY, NOVEMBER 6

Workshop - 2nd Workshop on Accelerator Computer Aided Design (ACCAD) 2020

Section One: Thursday, November 5: 8:00am - 12:00pm Section Two: Friday, November 6: 8:00am - 12:00pm

Organizers:

Abe Elfadel - Khalifa Univ. Subhasish Mitra - Stanford Univ.

This workshop provides a forum to present and discuss the current trends in computer-aided design in support of domain-specific accelerator chips, especially for artificial intelligence and machine learning applications. The workshop will be concerned with the VLSI methodology flow from high-level synthesis to physical verification and performance prediction, particularly in the way it gets impacted with the emerging design paradigms of domain-specific instruction sets, approximate computing, in-memory computing, and stochastic computing. Of particular interest to the workshop are the transformations that VLSI CAD has to undergo to adapt to the post-CMOS technologies when they are considered in the context of accelerator design. The workshop will include, but will not be limited to, the following topics:

- High-level synthesis of machine-learning accelerators
- Design space exploration of domain-specific accelerators
- Tools and methodologies for in-memory computing
- Tools and methodologies for approximate computing
- CAD for emerging accelerator technologies: ReRAM, MRAM, Photonics, etc.
- Tools and methodologies for the post-CNN era
- Tools and methodologies for the testing and verification of accelerator chips.

Each year, the workshop will be devoted to three focus areas of accelerator CAD. Renowned speakers are invited to speak on each of the three areas. The remainder of the workshop will be open to the larger community on the basis of a call-for-posters. Short oral presentations will be given by all the accepted poster presenters in advance of the poster session.

The four topics selected for this year are:

- 1. CAD for emerging accelerator technologies
- 2. High-level synthesis of machine-learning accelerators
- 3. Accelerator verification
- 4. Hardware/software co-acceleration

For complete details visit website: https://sites.google.com/masdar.ac.ae/accad2020/home.

Workshop - Workshop on Open-Source EDA Technology

Time: 9:00am - 1:00pm

Organizer:

Jose Renau - Alibaba DAMO Academy Matthew Guthaus - Univ. of California, Santa Cruz

This one-day workshop aims to galvanize the open-source EDA movement. The workshop will bring together EDA researchers who are committed to open-source principles to share their experiences and coordinate efforts towards developing a reliable, fully open-source EDA flow. The workshop will feature presentations and posters for existing and under-development open-source tools. The workshop will include a panel to brainstorm about potential gaps and obstacles to open-source EDA, and how to coordinate efforts and ensure quality and interoperability across open-source tools. A cash award will be given to the Best Tool Award.

The 2020 WOSET papers are available at WOSET 2020

https://woset-workshop.github.io/WOSET2020.html

Video presentations will be added roughly October 25, 2020.

The Q&A schedule will be posted soon.

https://woset-workshop.github.io/



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CAS

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